

# LC75857E, LC75857W

## 1/3, 1/4-Duty LCD Driver with Key Input Function

### Overview

The LC75857E and LC75857W are 1/3 duty and 1/4 duty LCD display drivers that can directly drive up to 164 segments and can control up to four general-purpose output ports. These products also incorporate a key scan circuit that accepts input from up to 30 keys to reduce printed circuit board wiring.

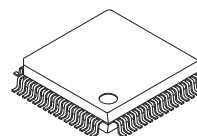
### Features

- Key input function for up to 30 keys  
(A key scan is performed only when a key is pressed.)
- 1/3 duty and 1/4 duty drive schemes can be controlled from serial data.
- 1/2 bias and 1/3 bias drive schemes can be controlled from serial data.
- Capable of driving up to 126 segments using 1/3 duty and up to 164 segments using 1/4 duty.
- Sleep mode and all segments off functions that are controlled from serial data.
- Switching between key scan output and segment output can be controlled from the serial data.
- The key scan operation enabled/disabled state can be controlled from the serial data.
- Switching between segment output port and general-purpose output port can be controlled from serial data.
- The common and segment output waveform frame frequency can be controlled from the serial data.
- Switching between RC oscillator mode and external clock mode can be controlled from the serial data.
- Serial data I/O supports CCB\* format communication with the system controller.
- Direct display of display data without the use of a decoder provides high generality.
- Independent VLCD for the LCD driver block.  
(When the logic block supply voltage  $V_{DD}$  is in the range 3.6 to 6.0 V, VLCD can be set to a voltage in the range  $0.75 \times V_{DD}$  to 6.0 V, and when  $V_{DD}$  is in the range 2.7 to 3.6 V, VLCD can be set to a voltage in the range 2.7 to 6.0 V.)
- Provision of an on-chip voltage-detection type reset circuit prevents incorrect displays.

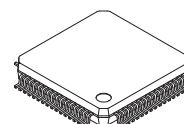


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PQFP64 14x14 / QIP64E  
[LC75857E]



SPQFP64 10x10 / SQFP64  
[LC75857W]

\* Computer Control Bus (CCB) is an ON Semiconductor's original bus format and the bus addresses are controlled by ON Semiconductor.

### ORDERING INFORMATION

See detailed ordering and shipping information on page 42 of this data sheet.

# LC75857E, LC75857W

## Specifications

**Absolute Maximum Ratings** at Ta=25°C, V<sub>SS</sub>=0V

| Parameter                   | Symbol               | Conditions                                         | Ratings                       | Unit |
|-----------------------------|----------------------|----------------------------------------------------|-------------------------------|------|
| Maximum supply voltage      | V <sub>DD</sub> max  | V <sub>DD</sub>                                    | −0.3 to +7.0                  | V    |
|                             | V <sub>LCD</sub> max | V <sub>LCD</sub>                                   | −0.3 to +7.0                  |      |
| Input voltage               | V <sub>IN1</sub>     | CE, CL, DI                                         | −0.3 to +7.0                  | V    |
|                             | V <sub>IN2</sub>     | OSC, TEST                                          | −0.3 to V <sub>DD</sub> +0.3  |      |
|                             | V <sub>IN3</sub>     | V <sub>LCD1</sub> , V <sub>LCD2</sub> , KI1 to KI5 | −0.3 to V <sub>LCD</sub> +0.3 |      |
| Output voltage              | V <sub>OUT1</sub>    | DO                                                 | −0.3 to +7.0                  | V    |
|                             | V <sub>OUT2</sub>    | OSC                                                | −0.3 to V <sub>DD</sub> +0.3  |      |
|                             | V <sub>OUT3</sub>    | S1 to S42, COM1 to COM4, KS1 to KS6, P1 to P4      | −0.3 to V <sub>LCD</sub> +0.3 |      |
| Output current              | I <sub>OUT1</sub>    | S1 to S42                                          | 300                           | μA   |
|                             | I <sub>OUT2</sub>    | COM1 to COM4                                       | 3                             | mA   |
|                             | I <sub>OUT3</sub>    | KS1 to KS6                                         | 1                             |      |
|                             | I <sub>OUT4</sub>    | P1 to P4                                           | 5                             |      |
| Allowable power dissipation | P <sub>d</sub> max   | Ta = 85°C                                          | 200                           | mW   |
| Operating temperature       | T <sub>opr</sub>     |                                                    | −40 to +85                    | °C   |
| Storage temperature         | T <sub>stg</sub>     |                                                    | −55 to +125                   | °C   |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

**Allowable Operating Ranges** at Ta = −40 to +85°C, V<sub>SS</sub>=0V

| Parameter                                    | Symbol            | Conditions                                                       | Ratings              |                      |                      | Unit |
|----------------------------------------------|-------------------|------------------------------------------------------------------|----------------------|----------------------|----------------------|------|
|                                              |                   |                                                                  | min                  | typ                  | max                  |      |
| Supply voltage                               | V <sub>DD</sub>   | V <sub>DD</sub>                                                  | 2.7                  |                      | 6.0                  | V    |
|                                              | V <sub>LCD</sub>  | V <sub>LCD</sub> : V <sub>DD</sub> = 3.6 V to 6.0 V              | 0.75 V <sub>DD</sub> |                      | 6.0                  |      |
|                                              |                   | V <sub>LCD</sub> : V <sub>DD</sub> = 2.7 V to 3.6 V              | 2.7                  |                      | 6.0                  |      |
| Input voltage                                | V <sub>LCD1</sub> | V <sub>LCD1</sub>                                                |                      | 2/3 V <sub>LCD</sub> | V <sub>LCD</sub>     | V    |
|                                              | V <sub>LCD2</sub> | V <sub>LCD2</sub>                                                |                      | 1/3 V <sub>LCD</sub> | V <sub>LCD</sub>     |      |
| Input high level voltage                     | V <sub>IH1</sub>  | CE, CL, DI                                                       | 0.8 V <sub>DD</sub>  |                      | 6.0                  | V    |
|                                              | V <sub>IH2</sub>  | KI1 to KI5                                                       | 0.6 V <sub>LCD</sub> |                      | V <sub>LCD</sub>     |      |
|                                              | V <sub>IH3</sub>  | OSC: External clock mode                                         | 0.7 V <sub>DD</sub>  |                      | V <sub>DD</sub>      |      |
| Input low level voltage                      | V <sub>IL1</sub>  | CE, CL, DI                                                       | 0                    |                      | 0.2 V <sub>DD</sub>  | V    |
|                                              | V <sub>IL2</sub>  | KI1 to KI5                                                       | 0                    |                      | 0.2 V <sub>LCD</sub> |      |
|                                              | V <sub>IL3</sub>  | OSC: External clock mode                                         | 0                    |                      | 0.3 V <sub>DD</sub>  |      |
| Recommended RC oscillator external resistor  | R <sub>OSC</sub>  | OSC: RC oscillator mode                                          |                      | 39                   |                      | kΩ   |
| Recommended RC oscillator external capacitor | C <sub>OSC</sub>  | OSC: RC oscillator mode                                          |                      | 1000                 |                      | pF   |
| Guaranteed RC oscillator operating range     | f <sub>OSC</sub>  | OSC: RC oscillator mode                                          | 19                   | 38                   | 76                   | kHz  |
| External clock frequency                     | f <sub>CK</sub>   | OSC: External clock mode :Figure 4                               | 19                   | 38                   | 76                   | kHz  |
| External clock duty                          | D <sub>CK</sub>   | OSC: External clock mode :Figure 4                               | 30                   | 50                   | 70                   | %    |
| Data setup time                              | t <sub>ds</sub>   | CL, DI :Figures 2,3                                              | 160                  |                      |                      | ns   |
| Data hold time                               | t <sub>dh</sub>   | CL, DI :Figures 2,3                                              | 160                  |                      |                      | ns   |
| CE wait time                                 | t <sub>cp</sub>   | CE, CL :Figures 2,3                                              | 160                  |                      |                      | ns   |
| CE setup time                                | t <sub>cs</sub>   | CE, CL :Figures 2,3                                              | 160                  |                      |                      | ns   |
| CE hold time                                 | t <sub>ch</sub>   | CE, CL :Figures 2,3                                              | 160                  |                      |                      | ns   |
| High level clock pulse width                 | t <sub>øH</sub>   | CL :Figures 2,3                                                  | 160                  |                      |                      | ns   |
| Low level clock pulse width                  | t <sub>øL</sub>   | CL :Figures 2,3                                                  | 160                  |                      |                      | ns   |
| Rise time                                    | t <sub>r</sub>    | CE, CL, DI :Figures 2,3                                          |                      | 160                  |                      | ns   |
| Fall time                                    | t <sub>f</sub>    | CE, CL, DI :Figures 2,3                                          |                      | 160                  |                      | ns   |
| DO output delay time                         | t <sub>dc</sub>   | DO R <sub>PU</sub> =4.7 kΩ, C <sub>L</sub> =10pF *1 :Figures 2,3 |                      |                      | 1.5                  | μs   |
| DO rise time                                 | t <sub>dr</sub>   | DO R <sub>PU</sub> =4.7 kΩ, C <sub>L</sub> =10pF *1 :Figures 2,3 |                      |                      | 1.5                  | μs   |

Note: \*1. Since DO is an open-drain output, these values depend on the resistance of the pull-up resistor R<sub>PU</sub> and the load capacitance C<sub>L</sub>.

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

# LC75857E, LC75857W

## Electrical Characteristics for the Allowable Operation Ranges

| Parameter                      | Symbol            | Conditions                                                                                    | Ratings                    |                        |                            | Unit |
|--------------------------------|-------------------|-----------------------------------------------------------------------------------------------|----------------------------|------------------------|----------------------------|------|
|                                |                   |                                                                                               | min                        | typ                    | max                        |      |
| Hysteresis                     | V <sub>H1</sub>   | CE, CL, DI                                                                                    |                            | 0.1 V <sub>DD</sub>    |                            | V    |
|                                | V <sub>H2</sub>   | KI1 to KI5                                                                                    |                            | 0.1 V <sub>LCD</sub>   |                            |      |
| Power-down detection voltage   | V <sub>DET</sub>  |                                                                                               | 2.0                        | 2.2                    | 2.4                        | V    |
| Input high level current       | I <sub>IH1</sub>  | CE, CL, DI: V <sub>I</sub> = 6.0 V                                                            |                            |                        | 5.0                        | μA   |
|                                | I <sub>IH2</sub>  | OSC: V <sub>I</sub> = V <sub>DD</sub> External clock mode                                     |                            |                        | 5.0                        |      |
| Input low level current        | I <sub>IL1</sub>  | CE, CL, DI: V <sub>I</sub> = 0 V                                                              | -5.0                       |                        |                            | μA   |
|                                | I <sub>IL2</sub>  | OSC: V <sub>I</sub> = 0 V External clock mode                                                 | -5.0                       |                        |                            |      |
| Input floating voltage         | V <sub>IF</sub>   | KI1 to KI5                                                                                    |                            |                        | 0.05 V <sub>LCD</sub>      | V    |
| Pull-down resistance           | R <sub>PD</sub>   | KI1 to KI5: V <sub>LCD</sub> = 5.0 V                                                          | 50                         | 100                    | 250                        | kΩ   |
|                                |                   | KI1 to KI5: V <sub>LCD</sub> = 3.0 V                                                          | 100                        | 200                    | 500                        |      |
| Output off leakage current     | I <sub>OFFH</sub> | DO: V <sub>O</sub> = 6.0 V                                                                    |                            |                        | 6.0                        | μA   |
| Output high level voltage      | V <sub>OH1</sub>  | KS1 to KS6: I <sub>O</sub> = -500 μA V <sub>LCD</sub> = 3.6 to 6.0 V                          | V <sub>LCD</sub> - 1.0     | V <sub>LCD</sub> - 0.5 | V <sub>LCD</sub> - 0.2     | V    |
|                                |                   | KS1 to KS6: I <sub>O</sub> = -250 μA V <sub>LCD</sub> = 2.7 to 3.6 V                          | V <sub>LCD</sub> - 0.8     | V <sub>LCD</sub> - 0.4 | V <sub>LCD</sub> - 0.1     |      |
|                                | V <sub>OH2</sub>  | P1 to P4: I <sub>O</sub> = -1 mA                                                              | V <sub>LCD</sub> - 0.9     |                        |                            |      |
|                                | V <sub>OH3</sub>  | S1 to S42: I <sub>O</sub> = -20 μA                                                            | V <sub>LCD</sub> - 0.9     |                        |                            |      |
| Output low level voltage       | V <sub>OH4</sub>  | COM1 to COM4: I <sub>O</sub> = -100 μA                                                        | V <sub>LCD</sub> - 0.9     |                        |                            | V    |
|                                | V <sub>OL1</sub>  | KS1 to KS6: I <sub>O</sub> = 25 μA V <sub>LCD</sub> = 3.6 to 6.0 V                            | 0.2                        | 0.5                    | 1.5                        |      |
|                                |                   | KS1 to KS6: I <sub>O</sub> = 12.5 μA V <sub>LCD</sub> = 2.7 to 3.6 V                          | 0.1                        | 0.4                    | 1.2                        |      |
|                                | V <sub>OL2</sub>  | P1 to P4: I <sub>O</sub> = 1 mA                                                               |                            |                        | 0.9                        |      |
|                                | V <sub>OL3</sub>  | S1 to S42: I <sub>O</sub> = 20 μA                                                             |                            |                        | 0.9                        |      |
| Output middle level voltage *2 | V <sub>OL4</sub>  | COM1 to COM4: I <sub>O</sub> = 100 μA                                                         |                            |                        | 0.9                        | V    |
|                                | V <sub>OL5</sub>  | DO: I <sub>O</sub> = 1 mA                                                                     |                            | 0.1                    | 0.5                        |      |
|                                | V <sub>MID1</sub> | COM1 to COM4: 1/2 bias, I <sub>O</sub> = ±100 μA                                              | 1/2 V <sub>LCD</sub> - 0.9 |                        | 1/2 V <sub>LCD</sub> + 0.9 |      |
|                                | V <sub>MID2</sub> | S1 to S42: 1/3 bias, I <sub>O</sub> = ±20 μA                                                  | 2/3 V <sub>LCD</sub> - 0.9 |                        | 2/3 V <sub>LCD</sub> + 0.9 |      |
|                                | V <sub>MID3</sub> | S1 to S42: 1/3 bias, I <sub>O</sub> = ±20 μA                                                  | 1/3 V <sub>LCD</sub> - 0.9 |                        | 1/3 V <sub>LCD</sub> + 0.9 |      |
| Oscillator frequency           | f <sub>osc</sub>  | OSC: R <sub>OSC</sub> = 39 kΩ, C <sub>OSC</sub> = 1000 pF                                     | 30.4                       | 38                     | 45.6                       | kHz  |
|                                |                   |                                                                                               |                            |                        |                            |      |
| Current drain                  | I <sub>DD1</sub>  | V <sub>DD</sub> : Sleep mode                                                                  |                            |                        | 100                        | μA   |
|                                | I <sub>DD2</sub>  | V <sub>DD</sub> : V <sub>DD</sub> = 6.0 V, output open, f <sub>osc</sub> = 38 kHz             |                            | 300                    | 600                        |      |
|                                | I <sub>LCD1</sub> | V <sub>LCD</sub> : Sleep mode                                                                 |                            |                        | 5                          |      |
|                                | I <sub>LCD2</sub> | V <sub>LCD</sub> : V <sub>LCD</sub> = 6.0 V, output open, 1/2 bias, f <sub>osc</sub> = 38 kHz |                            | 100                    | 200                        |      |
|                                | I <sub>LCD3</sub> | V <sub>LCD</sub> : V <sub>LCD</sub> = 6.0 V, output open, 1/3 bias, f <sub>osc</sub> = 38 kHz |                            | 60                     | 120                        |      |

Note: \*2. Excluding the bias voltage generation divider resistor built into V<sub>LCD1</sub> and V<sub>LCD2</sub>. (See Figure 1.)

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

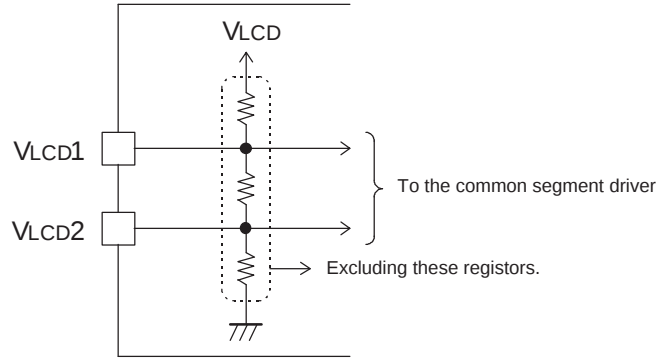


Figure 1

1. Serial data I/O timing when CL is stopped at the low level

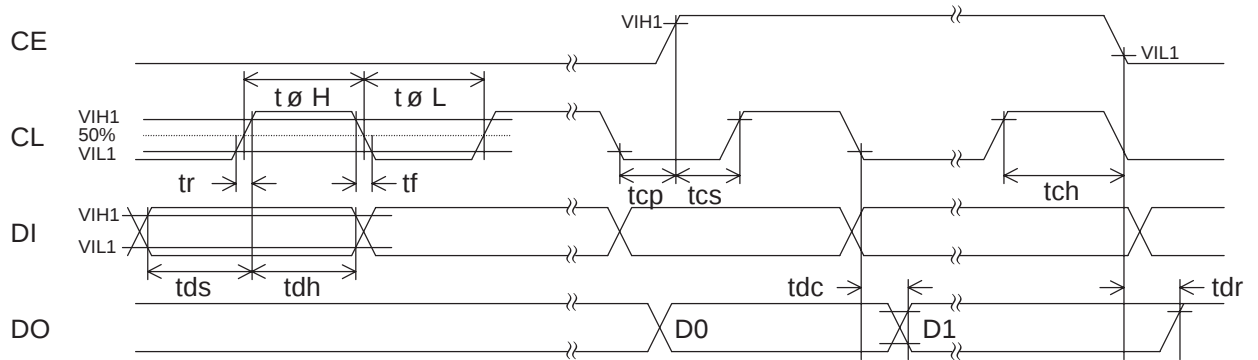


Figure 2

2. Serial data I/O timing when CL is stopped at the high level

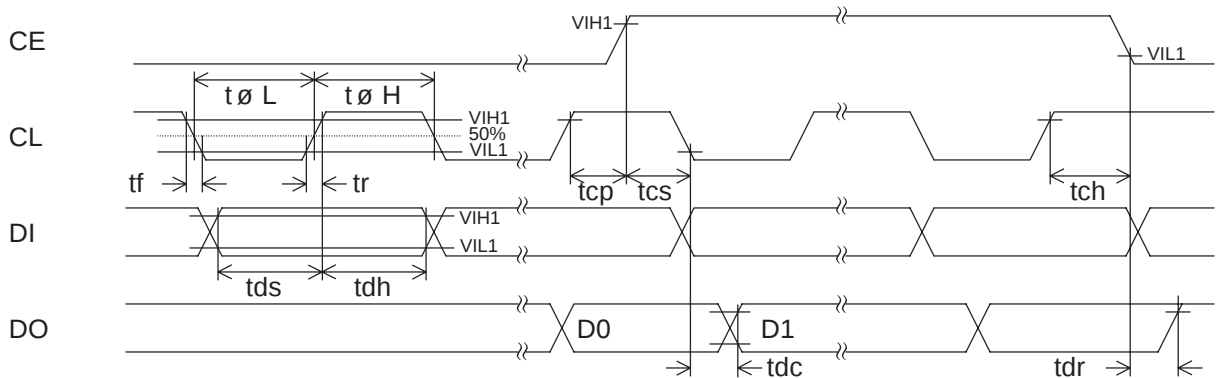


Figure 3

3. OSC pin clock timing in external clock mode

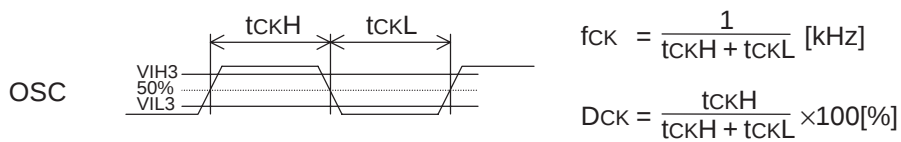
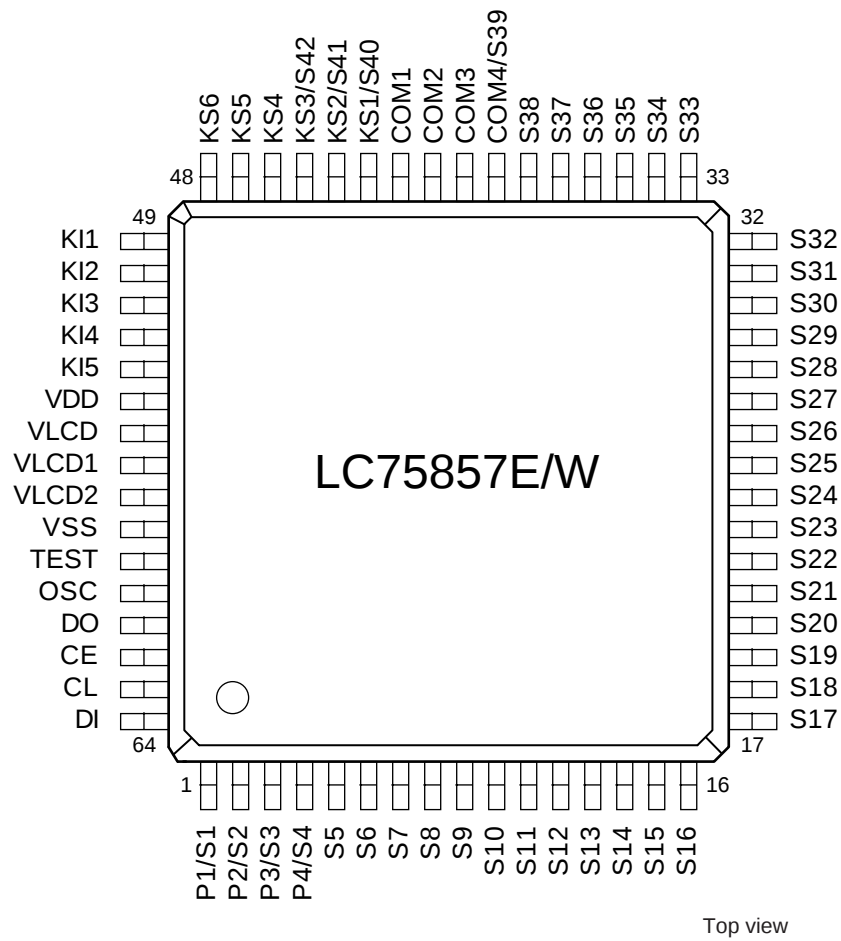
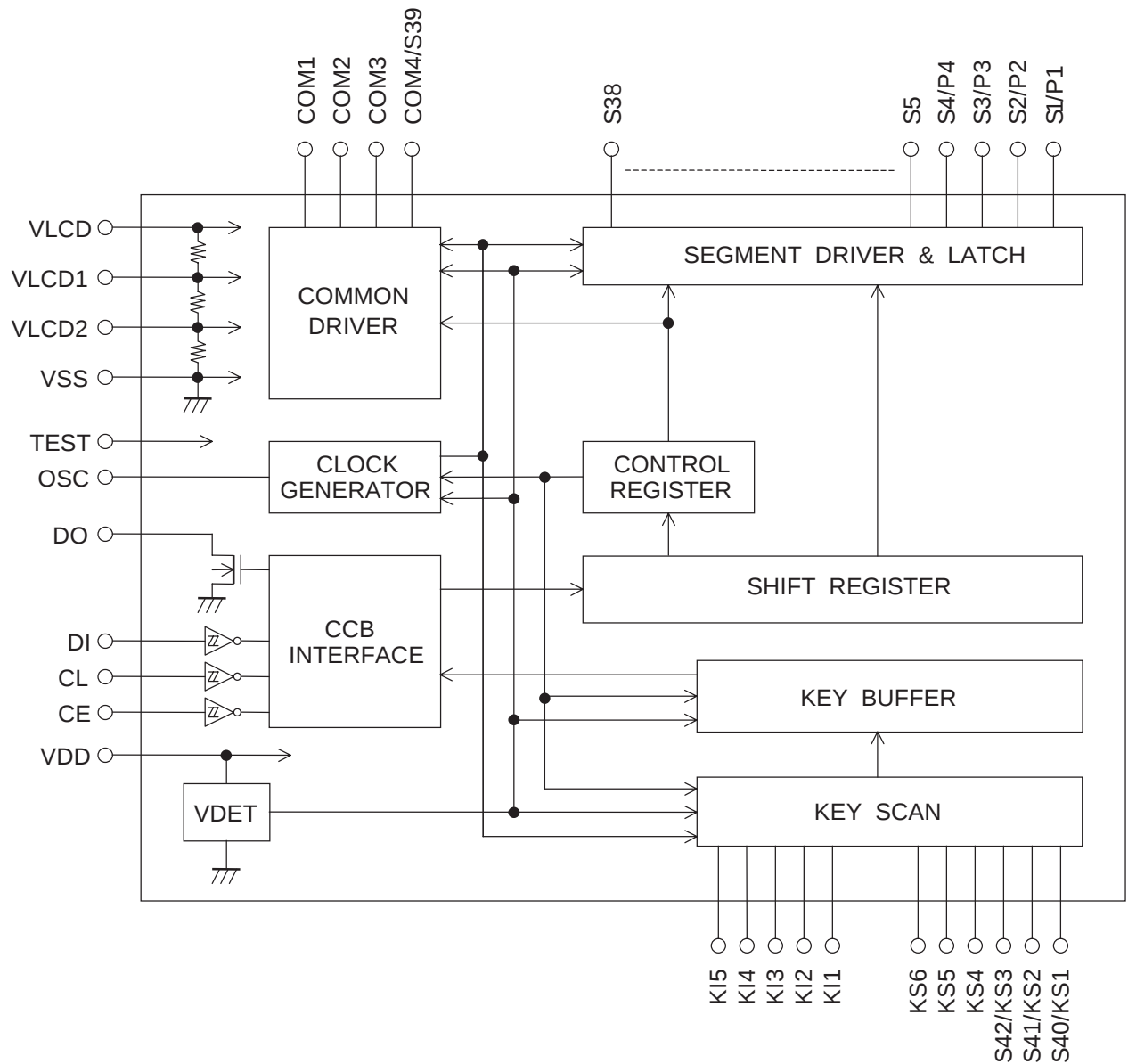


Figure 4

## Pin Assignments



# Block Diagram

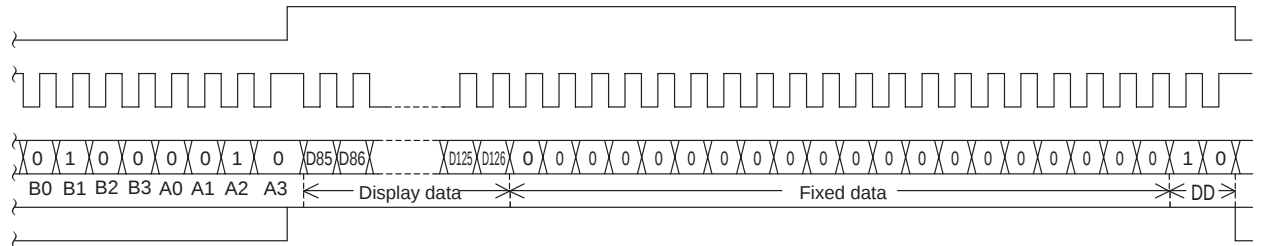
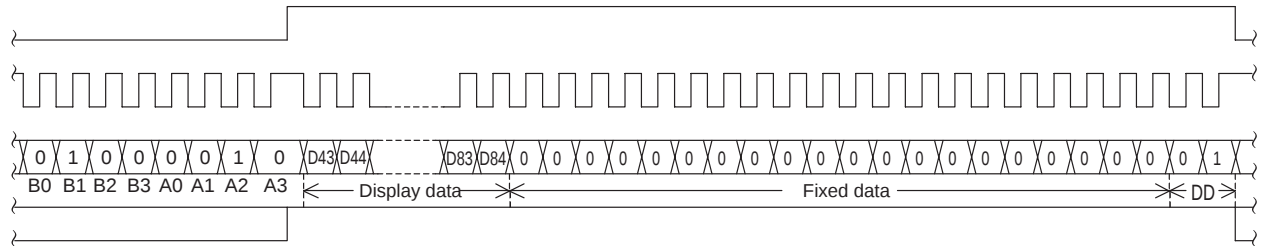
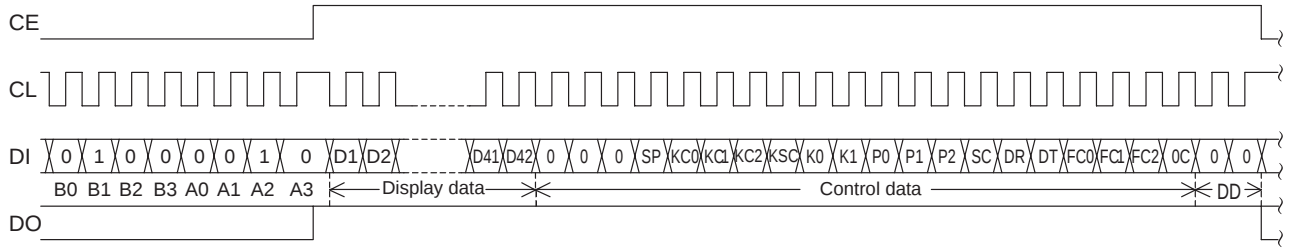


## Pin Functions

| Pin                                         | Pin No.                    | Function                                                                                                                                                                                                                                                                                                                                                                                     | Active                                                                                             | I/O              | Handling when unused |
|---------------------------------------------|----------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------|------------------|----------------------|
| S1/P1 to S4/P4<br>S5 to S38                 | 1 to 4<br>5 to 38          | Segment outputs for displaying the display data transferred by serial data input. The S1/P1 to S4/P4 pins can be used as general-purpose output ports under serial data control.                                                                                                                                                                                                             | —                                                                                                  | O                | OPEN                 |
| COM1 to COM3<br>COM4/S39                    | 42 to 40<br>39             | Common driver outputs<br>The frame frequency is fo [Hz]<br>The COM4/S39 pin can be used as a segment output in 1/3 duty.                                                                                                                                                                                                                                                                     | —                                                                                                  | O                | OPEN                 |
| KS1/S40<br>KS2/S41<br>KS3/S42<br>KS4 to KS6 | 43<br>44<br>45<br>46 to 48 | Key scan outputs<br>Although normal key scan timing lines require diodes to be inserted in the timing lines to prevent shorts, since these outputs are unbalanced CMOS transistor outputs, these outputs will not be damaged by shorting when these outputs are used to form a key matrix. The KS1/S40 to KS3/S42 pins can be used as segment outputs when so specified by the control data. | —                                                                                                  | O                | OPEN                 |
| KI1 to KI5                                  | 49 to 53                   | Key scan inputs<br>These pins have built-in pull-down resistors.                                                                                                                                                                                                                                                                                                                             | H                                                                                                  | I                | GND                  |
| OSC                                         | 60                         | The OSC pin can be used to form an oscillator circuit with an external resistor and an external capacitor. If external clock mode is selected with the control data, this pin is used to input an external clock signal.                                                                                                                                                                     | —                                                                                                  | I/O              | V <sub>DD</sub>      |
| CE<br>CL<br>DI<br>DO                        | 62<br>63<br>64<br>61       | Serial data interface connections to the controller. Note that DO, being an open-drain output, requires a pull-up resistor.<br>CE :Chip enable<br>CL :Synchronization clock<br>DI :Transfer data<br>DO :Output data                                                                                                                                                                          | H<br><br>—<br>— | I<br>I<br>I<br>O | GND<br>OPEN          |
| TEST                                        | 59                         | This pin must be connected to ground.                                                                                                                                                                                                                                                                                                                                                        | —                                                                                                  | I                | —                    |
| V <sub>LCD1</sub>                           | 56                         | Used for applying the LCD drive 2/3 bias voltage externally. Must be connected to V <sub>LCD2</sub> when a 1/2 bias drive scheme is used.                                                                                                                                                                                                                                                    | —                                                                                                  | I                | OPEN                 |
| V <sub>LCD2</sub>                           | 57                         | Used for applying the LCD drive 1/3 bias voltage externally. Must be connected to V <sub>LCD1</sub> when a 1/2 bias drive scheme is used.                                                                                                                                                                                                                                                    | —                                                                                                  | I                | OPEN                 |
| V <sub>DD</sub>                             | 54                         | Logic block power supply connection. Provide a voltage of between 2.7 and 6.0V.                                                                                                                                                                                                                                                                                                              | —                                                                                                  | —                | —                    |
| V <sub>LCD</sub>                            | 55                         | LCD driver block power supply connection. A voltage in the range $0.75 \times V_{DD}$ to 6.0 V must be provided when V <sub>DD</sub> is in the range 3.6 to 6.0 V, and a voltage in the range 2.7 V to 6.0 V must be provided when V <sub>DD</sub> is in the range 2.7 to 3.6 V.                                                                                                             | —                                                                                                  | —                | —                    |
| V <sub>SS</sub>                             | 58                         | Power supply connection. Connect to ground.                                                                                                                                                                                                                                                                                                                                                  | —                                                                                                  | —                | —                    |



(2) When CL is stopped at the high level

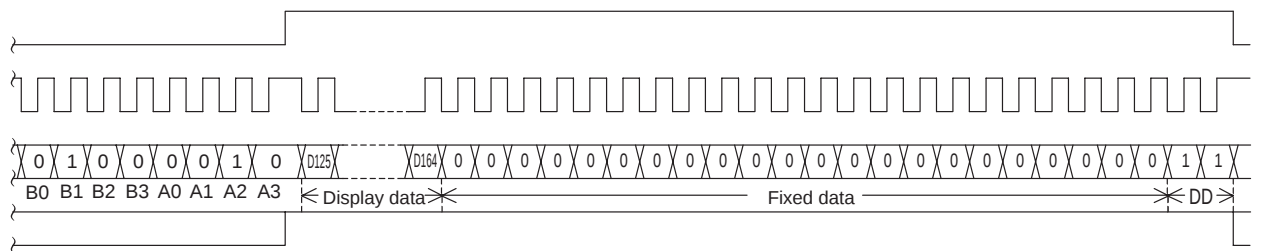
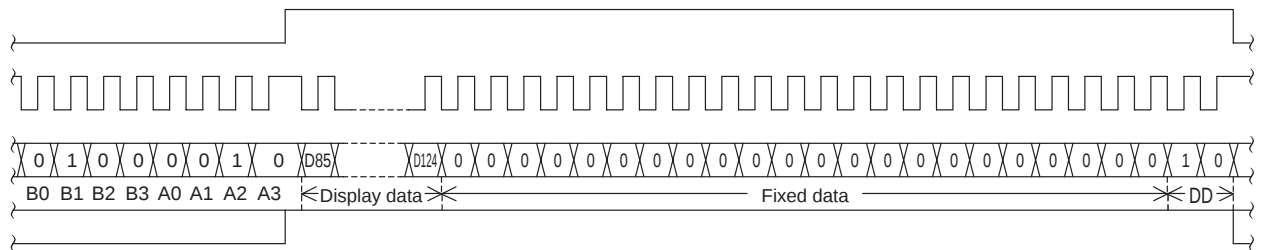
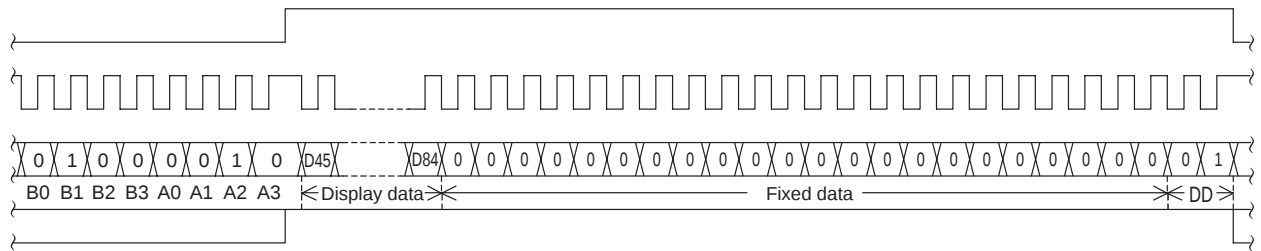
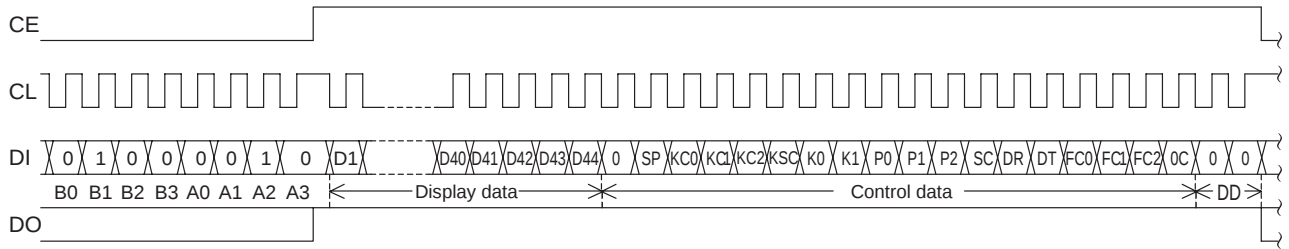


Note: B0 to B3, A0 to A3 ..... CCB address  
DD ..... Direction data

CCB address ..... 42H  
D1 to D126 ..... Display data  
SP ..... Normal mode/sleep mode control data  
KC0 to KC2 ..... Key scan output state setting data  
KSC ..... Key scan operation enabled/disabled state setting data  
K0, K1 ..... Key scan output/segment output selection data  
P0 to P2 ..... Segment output port/general-purpose output port selection data  
SC ..... Segment on/off control data  
DR ..... 1/2 bias or 1/3 bias drive selection data  
DT ..... 1/3 duty or 1/4 duty drive selection data  
FC0 to FC2 ..... Common and segment output waveform frame frequency setting data  
OC ..... RC oscillator mode/external clock mode switching selection data



(2) When CL is stopped at the high level



Note: B0 to B3, A0 to A3 ..... CCB address  
DD ..... Direction data

CCB address ..... 42H  
D1 to D164 ..... Display data  
SP ..... Normal mode/sleep mode control data  
KC0 to KC2 ..... Key scan output state setting data  
KSC ..... Key scan operation enabled/disabled state setting data  
K0, K1 ..... Key scan output/segment output selection data  
P0 to P2 ..... Segment output port/general-purpose output port selection data  
SC ..... Segment on/off control data  
DR ..... 1/2 bias or 1/3 bias drive selection data  
DT ..... 1/3 duty or 1/4 duty drive selection data  
FC0 to FC2 ..... Common and segment output waveform frame frequency setting data  
OC ..... RC oscillator mode/external clock mode switching selection data

## Control Data Functions

### 1. SP : Normal mode/sleep mode control data

This control data bit switches the IC between normal mode and sleep mode.

| SP | Mode   | OSC pin state                                                               |                                                                                                                            | Common and segment pin output states | Key scan operating state | General-purpose output port states |
|----|--------|-----------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------|--------------------------------------|--------------------------|------------------------------------|
|    |        | RC oscillator mode                                                          | External clock mode                                                                                                        |                                      |                          |                                    |
| 0  | Normal | Oscillator operating                                                        | External clock signal accepted                                                                                             | LCD drive waveforms are output       | The state can be set     | The state can be set               |
| 1  | sleep  | Oscillator stopped<br>(The oscillator operates during key scan operations.) | Acceptance of the external clock signal is disabled.<br>(The external clock signal is accepted during key scan operations) | L (VSS)                              |                          |                                    |

Note: See the descriptions of the KC0 to KC2, KSC, K0, K1, and P0 to P2 bits in the control data for details on setting the key scan operating state and setting the general-purpose output port state.

### 2. KC0 to KC2 : Key scan output state setting data

These control data bits set the states of the key scan output pins KS1 to KS6.

| Control data |     |     | Output pin states during key scan standby |     |     |     |     |     |
|--------------|-----|-----|-------------------------------------------|-----|-----|-----|-----|-----|
| KC0          | KC1 | KC2 | KS1                                       | KS2 | KS3 | KS4 | KS5 | KS6 |
| 0            | 0   | 0   | H                                         | H   | H   | H   | H   | H   |
| 0            | 0   | 1   | L                                         | H   | H   | H   | H   | H   |
| 0            | 1   | 0   | L                                         | L   | H   | H   | H   | H   |
| 0            | 1   | 1   | L                                         | L   | L   | H   | H   | H   |
| 1            | 0   | 0   | L                                         | L   | L   | L   | H   | H   |
| 1            | 0   | 1   | L                                         | L   | L   | L   | L   | H   |
| 1            | 1   | 0   | L                                         | L   | L   | L   | L   | L   |

Note: This assumes that the KS1/S40 to KS3/S42 output pins are selected for key scan output.  
Also note that key scan output signals are not output from output pins that are set to the low level.

### 3. KSC : Key scan operation enabled/disabled state setting data

This control data bit enables or disables key scan operation.

| KSC | Key scan operating state                                                                                                                                                                                                                                  |
|-----|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 0   | Key scan operation enabled<br>(A key scan operation is performed if any key on the lines corresponding to KS1 to KS6 pin which is set high is pressed.)                                                                                                   |
| 1   | Key scan operation disabled<br>(No key scan operation is performed, even if any of the keys in the key matrix are pressed. If this state is set up, the key data is forcibly reset to 0 and the key data read request is also cleared. (DO is set high.)) |

### 4. K0, K1 : Key scan output /segment output selection data

These control data bits switch the functions of the KS1/S40 to KS3/S42 output pins between key scan output and segment output.

| Control data |    | Output pin state |         |         | Maximum number of input keys |
|--------------|----|------------------|---------|---------|------------------------------|
| K0           | K1 | KS1/S40          | KS2/S41 | KS3/S42 |                              |
| 0            | 0  | KS1              | KS2     | KS3     | 30                           |
| 0            | 1  | S40              | KS2     | KS3     | 25                           |
| 1            | 0  | S40              | S41     | KS3     | 20                           |
| 1            | 1  | S40              | S41     | S42     | 15                           |

Note: KSn(n = 1 to 3) : Key scan output  
Sn (n = 40 to 42): Segment output

5. P0 to P2 : Segment output port/general-purpose output port selection data

These control data bits switch the functions of the S1/P1 to S4/P4 output pins between the segment output port and the general-purpose output port.

| Control data |    |    | Output pin state |       |       |       |
|--------------|----|----|------------------|-------|-------|-------|
| P0           | P1 | P2 | S1/P1            | S2/P2 | S3/P3 | S4/P4 |
| 0            | 0  | 0  | S1               | S2    | S3    | S4    |
| 0            | 0  | 1  | P1               | S2    | S3    | S4    |
| 0            | 1  | 0  | P1               | P2    | S3    | S4    |
| 0            | 1  | 1  | P1               | P2    | P3    | S4    |
| 1            | 0  | 0  | P1               | P2    | P3    | P4    |

Note: Sn(n=1 to 4): Segment output port

Pn(n=1 to 4): General-purpose output port

The table below lists the correspondence between the display data and the output pins when these pins are selected to be general-purpose output ports.

| Output pin | Corresponding display data |          |
|------------|----------------------------|----------|
|            | 1/3 duty                   | 1/4 duty |
| S1/P1      | D1                         | D1       |
| S2/P2      | D4                         | D5       |
| S3/P3      | D7                         | D9       |
| S4/P4      | D10                        | D13      |

For example, if the circuit is operated in 1/4 duty and the S4/P4 output pin is selected to be a general-purpose output port, the S4/P4 output pin will output a high level ( $V_{LCD}$ ) when the display data D13 is 1, and will output a low level ( $V_{ss}$ ) when D13 is 0.

6. SC : Segment on/off control data

This control data bit controls the on/off state of the segments.

| SC | Display state |
|----|---------------|
| 0  | on            |
| 1  | off           |

However, note that when the segments are turned off by setting SC to 1, the segments are turned off by outputting segment off waveforms from the segment output pins.

7. DR : 1/2 bias or 1/3 bias drive selection data

This control data bit switches between LCD 1/2 bias or 1/3 bias drive.

| DR | Bias drive scheme |
|----|-------------------|
| 0  | 1/3 bias drive    |
| 1  | 1/2 bias drive    |

8. DT : 1/3 duty or 1/4 duty drive selection data

This control data bit switches between LCD 1/3 duty or 1/4 duty drive.

| DT | Duty drive scheme | Output pin state (COM4/S39) |
|----|-------------------|-----------------------------|
| 0  | 1/4 duty drive    | COM4                        |
| 1  | 1/3 duty drive    | S39                         |

Note: COM4: Common output

S39 : Segment output

9. FC0 to FC2 : Common and segment output waveform frame frequency setting data  
These control data bits set the common and segment output waveform frequency.

| Control data |     |     | Frame frequency, fo (Hz)  |
|--------------|-----|-----|---------------------------|
| FC0          | FC1 | FC2 |                           |
| 0            | 0   | 0   | $f_{OSC}/768, f_{CK}/768$ |
| 0            | 0   | 1   | $f_{OSC}/576, f_{CK}/576$ |
| 0            | 1   | 0   | $f_{OSC}/384, f_{CK}/384$ |
| 0            | 1   | 1   | $f_{OSC}/288, f_{CK}/288$ |
| 1            | 0   | 0   | $f_{OSC}/192, f_{CK}/192$ |

10. OC : RC oscillator mode/external clock mode switching selection data  
This control data bit selects the OSC pin function (RC oscillator mode or external clock mode).

| OC | OSC pin function    |
|----|---------------------|
| 0  | RC oscillator mode  |
| 1  | External clock mode |

Note: If RC oscillator mode is selected, connect an external resistor  $R_{osc}$  and an external capacitor  $C_{osc}$  to the OSC pin.

## Display Data and Output Pin Correspondence

### 1. 1/3 duty

| Output pin | COM1 | COM2 | COM3 | Output pin | COM1 | COM2 | COM3 |
|------------|------|------|------|------------|------|------|------|
| S1/P1      | D1   | D2   | D3   | S22        | D64  | D65  | D66  |
| S2/P2      | D4   | D5   | D6   | S23        | D67  | D68  | D69  |
| S3/P3      | D7   | D8   | D9   | S24        | D70  | D71  | D72  |
| S4/P4      | D10  | D11  | D12  | S25        | D73  | D74  | D75  |
| S5         | D13  | D14  | D15  | S26        | D76  | D77  | D78  |
| S6         | D16  | D17  | D18  | S27        | D79  | D80  | D81  |
| S7         | D19  | D20  | D21  | S28        | D82  | D83  | D84  |
| S8         | D22  | D23  | D24  | S29        | D85  | D86  | D87  |
| S9         | D25  | D26  | D27  | S30        | D88  | D89  | D90  |
| S10        | D28  | D29  | D30  | S31        | D91  | D92  | D93  |
| S11        | D31  | D32  | D33  | S32        | D94  | D95  | D96  |
| S12        | D34  | D35  | D36  | S33        | D97  | D98  | D99  |
| S13        | D37  | D38  | D39  | S34        | D100 | D101 | D102 |
| S14        | D40  | D41  | D42  | S35        | D103 | D104 | D105 |
| S15        | D43  | D44  | D45  | S36        | D106 | D107 | D108 |
| S16        | D46  | D47  | D48  | S37        | D109 | D110 | D111 |
| S17        | D49  | D50  | D51  | S38        | D112 | D113 | D114 |
| S18        | D52  | D53  | D54  | COM4/S39   | D115 | D116 | D117 |
| S19        | D55  | D56  | D57  | KS1/S40    | D118 | D119 | D120 |
| S20        | D58  | D59  | D60  | KS2/S41    | D121 | D122 | D123 |
| S21        | D61  | D62  | D63  | KS3/S42    | D124 | D125 | D126 |

Note: This is for the case where the output pins S1/P1 to S4/P4, COM4/S74, KS1/S40 to KS3/S42 are selected for use as segment outputs.

For example, the table below lists the segment output states for the S11 output pin.

| Display data |     |     | Output pin state (S11)                            |
|--------------|-----|-----|---------------------------------------------------|
| D31          | D32 | D33 |                                                   |
| 0            | 0   | 0   | The LCD segments for COM1, COM2 and COM3 are off. |
| 0            | 0   | 1   | The LCD segment for COM3 is on.                   |
| 0            | 1   | 0   | The LCD segment for COM2 is on.                   |
| 0            | 1   | 1   | The LCD segments for COM2 and COM3 are on.        |
| 1            | 0   | 0   | The LCD segment for COM1 is on.                   |
| 1            | 0   | 1   | The LCD segments for COM1 and COM3 are on.        |
| 1            | 1   | 0   | The LCD segments for COM1 and COM2 are on.        |
| 1            | 1   | 1   | The LCD segments for COM1, COM2 and COM3 are on.  |

## 2. 1/4 duty

| Output pin | COM1 | COM2 | COM3 | COM4 |
|------------|------|------|------|------|
| S1/P1      | D1   | D2   | D3   | D4   |
| S2/P2      | D5   | D6   | D7   | D8   |
| S3/P3      | D9   | D10  | D11  | D12  |
| S4/P4      | D13  | D14  | D15  | D16  |
| S5         | D17  | D18  | D19  | D20  |
| S6         | D21  | D22  | D23  | D24  |
| S7         | D25  | D26  | D27  | D28  |
| S8         | D29  | D30  | D31  | D32  |
| S9         | D33  | D34  | D35  | D36  |
| S10        | D37  | D38  | D39  | D40  |
| S11        | D41  | D42  | D43  | D44  |
| S12        | D45  | D46  | D47  | D48  |
| S13        | D49  | D50  | D51  | D52  |
| S14        | D53  | D54  | D55  | D56  |
| S15        | D57  | D58  | D59  | D60  |
| S16        | D61  | D62  | D63  | D64  |
| S17        | D65  | D66  | D67  | D68  |
| S18        | D69  | D70  | D71  | D72  |
| S19        | D73  | D74  | D75  | D76  |
| S20        | D77  | D78  | D79  | D80  |
| S21        | D81  | D82  | D83  | D84  |

| Output pin | COM1 | COM2 | COM3 | COM4 |
|------------|------|------|------|------|
| S22        | D85  | D86  | D87  | D88  |
| S23        | D89  | D90  | D91  | D92  |
| S24        | D93  | D94  | D95  | D96  |
| S25        | D97  | D98  | D99  | D100 |
| S26        | D101 | D102 | D103 | D104 |
| S27        | D105 | D106 | D107 | D108 |
| S28        | D109 | D110 | D111 | D112 |
| S29        | D113 | D114 | D115 | D116 |
| S30        | D117 | D118 | D119 | D120 |
| S31        | D121 | D122 | D123 | D124 |
| S32        | D125 | D126 | D127 | D128 |
| S33        | D129 | D130 | D131 | D132 |
| S34        | D133 | D134 | D135 | D136 |
| S35        | D137 | D138 | D139 | D140 |
| S36        | D141 | D142 | D143 | D144 |
| S37        | D145 | D146 | D147 | D148 |
| S38        | D149 | D150 | D151 | D152 |
| KS1/S40    | D153 | D154 | D155 | D156 |
| KS2/S41    | D157 | D158 | D159 | D160 |
| KS3/S42    | D161 | D162 | D163 | D164 |

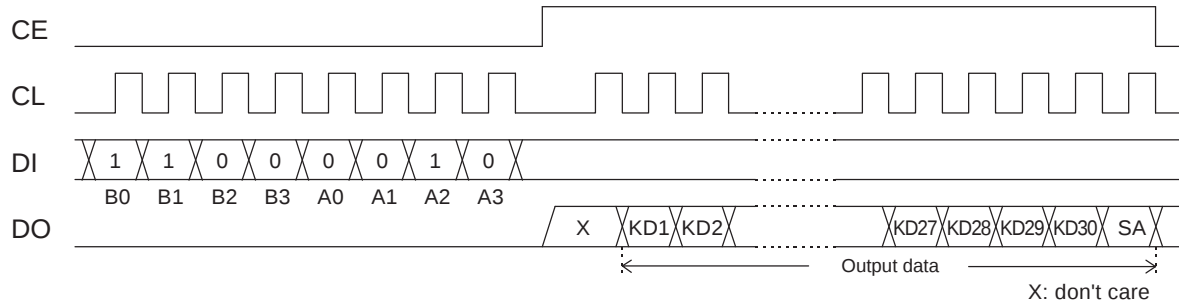
Note: This is for the case where the output pins S1/P1 to S4/P4, KS1/S40 to KS3/S42 are selected for use as segment outputs.

For example, the table below lists the segment output states for the S11 output pin.

| Display data |     |     |     | Output pin state (S11)                                  |
|--------------|-----|-----|-----|---------------------------------------------------------|
| D41          | D42 | D43 | D44 |                                                         |
| 0            | 0   | 0   | 0   | The LCD segments for COM1, COM2, COM3 and COM4 are off. |
| 0            | 0   | 0   | 1   | The LCD segment for COM4 is on.                         |
| 0            | 0   | 1   | 0   | The LCD segment for COM3 is on.                         |
| 0            | 0   | 1   | 1   | The LCD segments for COM3 and COM4 are on.              |
| 0            | 1   | 0   | 0   | The LCD segment for COM2 is on.                         |
| 0            | 1   | 0   | 1   | The LCD segments for COM2 and COM4 are on.              |
| 0            | 1   | 1   | 0   | The LCD segments for COM2 and COM3 are on.              |
| 0            | 1   | 1   | 1   | The LCD segments for COM2, COM3 and COM4 are on.        |
| 1            | 0   | 0   | 0   | The LCD segment for COM1 is on.                         |
| 1            | 0   | 0   | 1   | The LCD segments for COM1 and COM4 are on.              |
| 1            | 0   | 1   | 0   | The LCD segments for COM1 and COM3 are on.              |
| 1            | 0   | 1   | 1   | The LCD segments for COM1, COM3 and COM4 are on.        |
| 1            | 1   | 0   | 0   | The LCD segments for COM1 and COM2 are on.              |
| 1            | 1   | 0   | 1   | The LCD segments for COM1, COM2 and COM4 are on.        |
| 1            | 1   | 1   | 0   | The LCD segments for COM1, COM2 and COM3 are on.        |
| 1            | 1   | 1   | 1   | The LCD segments for COM1, COM2, COM3 and COM4 are on.  |

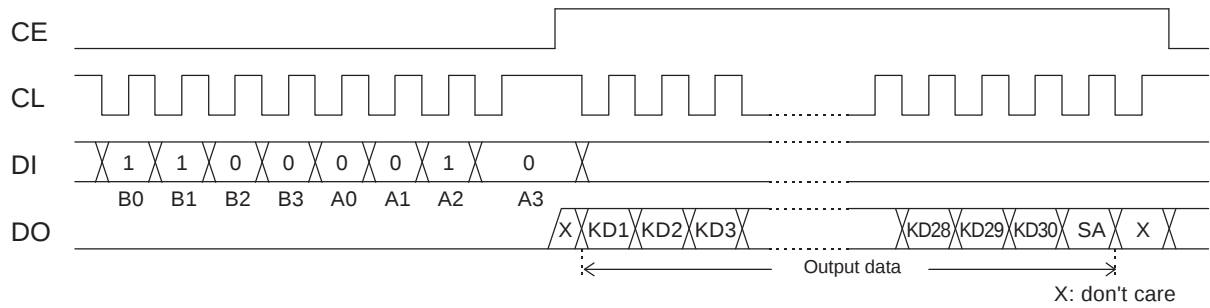
## Serial Data Output

### 1. When CL is stopped at the low level



Note: B0 to B3, A0 to A3.....CCB address

### 2. When CL is stopped at the high level



Note: B0 to B3, A0 to A3.....CCB address

CCB address ..... 43H

KD1 to KD30..... Key data

SA..... Sleep acknowledge data

Note: If a key data read operation is executed when DO is high, the read key data (KD1 to KD30) and sleep acknowledge data(SA) will be invalid.

## Output Data

### 1. KD1 to KD30 : Key data

When a key matrix of up to 30 keys is formed from the KS1 to KS6 output pins and the KI1 to KI5 input pins and one of those keys is pressed, the key output data corresponding to that key will be set to 1. The table shows the relationship between those pins and the key data bits.

|         | KI1  | KI2  | KI3  | KI4  | KI5  |
|---------|------|------|------|------|------|
| KS1/S40 | KD1  | KD2  | KD3  | KD4  | KD5  |
| KS2/S41 | KD6  | KD7  | KD8  | KD9  | KD10 |
| KS3/S42 | KD11 | KD12 | KD13 | KD14 | KD15 |
| KS4     | KD16 | KD17 | KD18 | KD19 | KD20 |
| KS5     | KD21 | KD22 | KD23 | KD24 | KD25 |
| KS6     | KD26 | KD27 | KD28 | KD29 | KD30 |

When the KS1/S40 and KS2/S41 output pins are selected to be segment outputs by control data bits K0 and K1 and a key matrix of up to 20 keys is formed using the KS3/S42, KS4 to KS6 output pins and the KI1 to KI5 input pins, the KD1 to KD10 key data bits will be set to 0.

### 2. SA : Sleep acknowledge data

This output data bit is set to the state when the key was pressed. Also, while DO will be low in this case, if serial data is input and the mode is set (to normal or sleep mode) during this period, that mode will be set. SA will be 1 in sleep mode and 0 in normal mode.

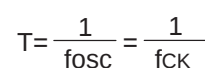
## Sleep Mode Functions

Sleep mode is set up by setting SP in the control data to 1. When sleep mode is set up, both the segment and the common outputs will go to the low level. In RC oscillator mode (OC = 0), the oscillator on the OSC pin will stop (although it will operate during key scan operations), and in external clock mode (OC = 1), the external clock signal reception on the OSC pin will stop (although the clock signal will be received during key scan operations). Thus this mode reduces power consumption. However, the S1/P1 to S4/P4 output pins can be used as general-purpose output ports under control of the P0 to P2 bits in the control data even in sleep mode. Sleep mode is cancelled by setting SP in the control data to 0.

The key scan period is 288T(s). To reliably determine the on/off state of the keys, the LC75857E/W scans the keys twice and determines that a key has been pressed when the key data agrees. It outputs a key data read request (a low level on DO) 615T(s) after starting a key scan. If the key data dose not agree and a key was pressed at that point, it scans the keys again. Thus the LC75857E/W cannot detect a key press shorter than 615T(s).



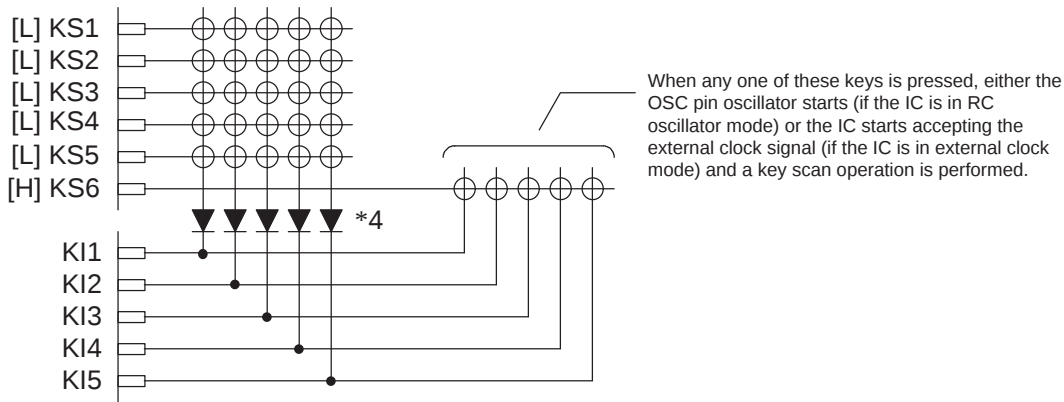
- The KS1 to KS6 pins are set to the high or low level by the KC0 to KC2 bits in the control data. (See the description of the control data.)
- When any key on the lines corresponding to KS1 to KS6 pin which is set high is pressed, a key scan is performed. Keys are scanned until all keys are released. Multiple key presses are recognized by determining whether multiple key data bits are set.
- If a key is pressed for longer than  $615 T(s)$  (Where  $T = \frac{1}{f_{osc}} = \frac{1}{f_{CK}}$ ) the LC75857E/W outputs a key data read request (a low level on DO) to the controller. The controller acknowledges this request and reads the key data. However, if CE is high during a serial data transfer, DO will be set high.
- After the controller reads the key data, the key data read request is cleared (DO is set high) and the LC75857E/W performs another key scan. Also note that DO, being an open-drain output, requires a pull-up resistor (between 1 to 10 k $\Omega$ ).



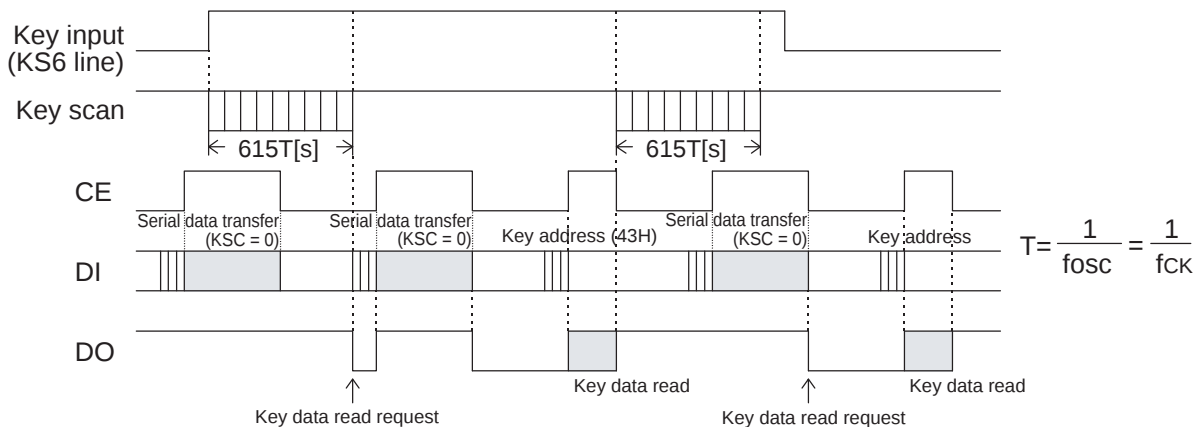
### 3. Sleep mode, when key scan operations are enabled

- The KS1 to KS6 pins are set to the high or low level by the KC0 to KC2 bits in the control data. (See the description of the control data.)
- When any key on the lines corresponding to KS1 to KS6 pin which is set high is pressed, either the OSC pin oscillator starts (if the IC is in RC oscillator mode) or the IC starts accepting the external clock signal (if the IC is in external clock mode), a key scan is performed. Keys are scanned until all keys are released. Multiple key presses are recognized by determining whether multiple key data bits are set.
- If a key is pressed for longer than  $615T(s)$  (Where  $T = \frac{1}{f_{osc}} = \frac{1}{f_{ck}}$ ) the LC75857E/W outputs a key data read request (a low level on DO) to the controller. The controller acknowledges this request and reads the key data. However, if CE is high during a serial data transfer, DO will be set high.
- After the controller reads the key data, the key data read request is cleared (DO is set high) and the LC75857E/W performs another key scan. However, this does not clear sleep mode. Also note that DO, being an open-drain output, requires a pull-up resistor (between 1 and 10 kΩ).
- Sleep mode key scan example

Example: KC0 = 1, KC1 = 0, KC2 = 1, (sleep with only KS6 high)

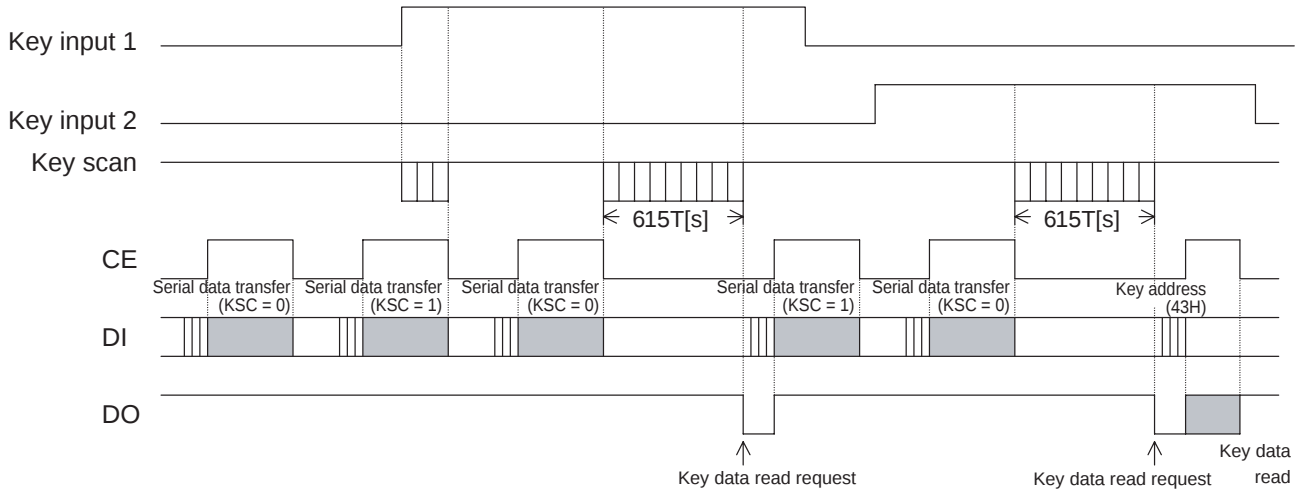


Note: \*4. These diodes are required to reliably recognize multiple key presses on the KS6 line when sleep mode state with only KS6 high, as in the above example. That is, these diodes prevent incorrect operations due to sneak currents in the KS6 key scan output signal when keys on the KS1 to KS5 lines are pressed at the same time.



4. Normal/sleep mode, when key scan operations are disabled

- The KS1 to KS6 pins are set to the high or low level by the KC0 to KC2 bits in the control data.
- No key scan operation is performed, whichever key is pressed.
- If the key scan disabled state (KSC = 1 in the control data) is set during a key scan, the key scan is stopped.
- If the key scan disabled state (KSC = 1 in the control data) is set when a key data read request (a low level on DO) is output to the controller, all the key data is set to 0 and the key data read request is cleared (DO is set high).  
Note that DO, being an open-drain output, requires a pull-up resistor (between 1 to 10 kΩ).
- The key scan disabled state is cleared by setting KSC in the control data to 0.

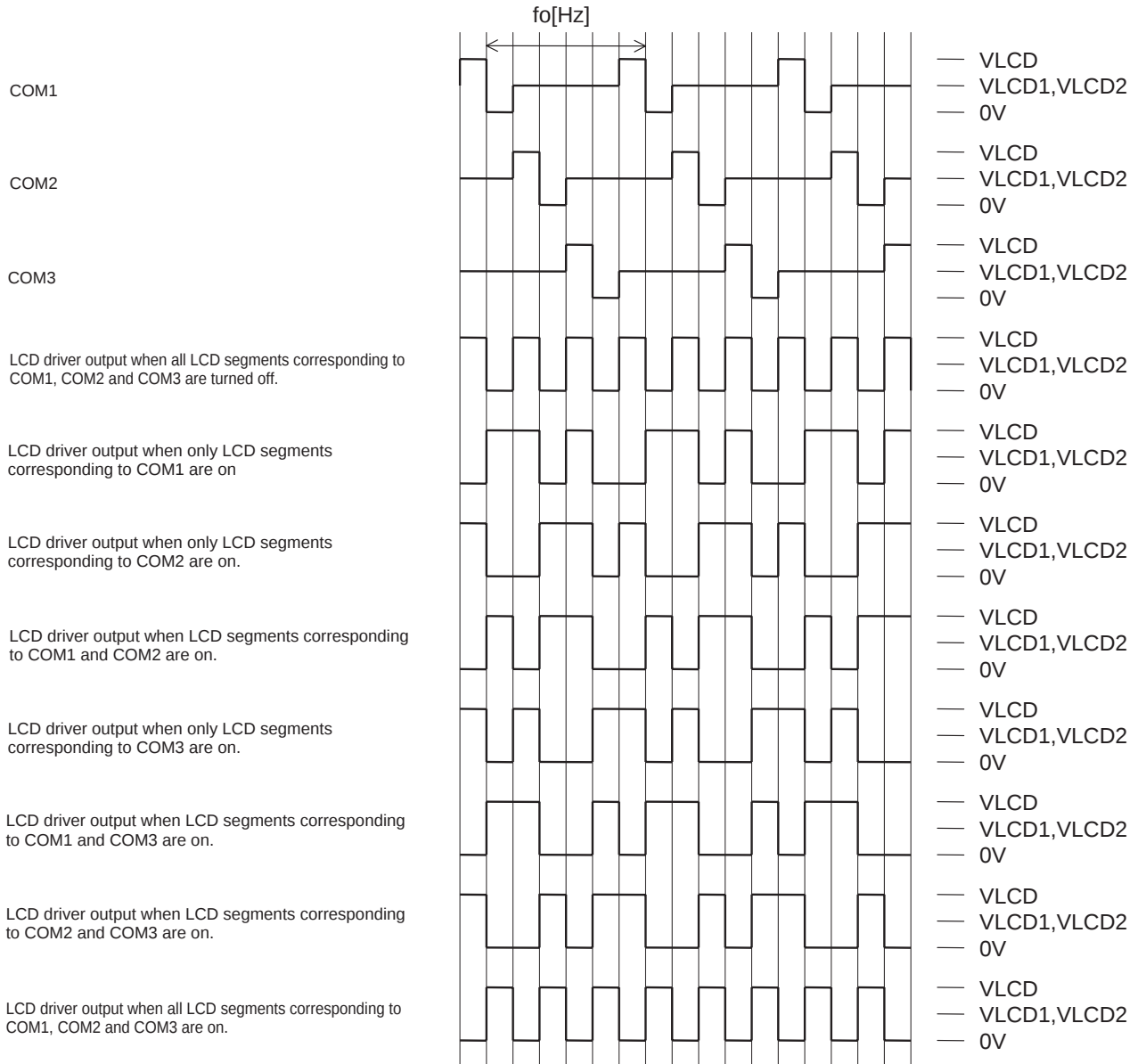


$$T = \frac{1}{f_{osc}} = \frac{1}{f_{CK}}$$

### Multiple Key Presses

Although the LC75857E/W is capable of key scanning without inserting diodes for dual key presses, triple key presses on the KI1 to KI5 input pin lines, or multiple key presses on the KS1 to KS6 output pin lines, multiple presses other than these cases may result in keys that were not pressed recognized as having been pressed. Therefore, a diode must be inserted in series with each key. Applications that do not recognize multiple key presses of three or more keys should check the key data for three or more 1 bits and ignore such data.

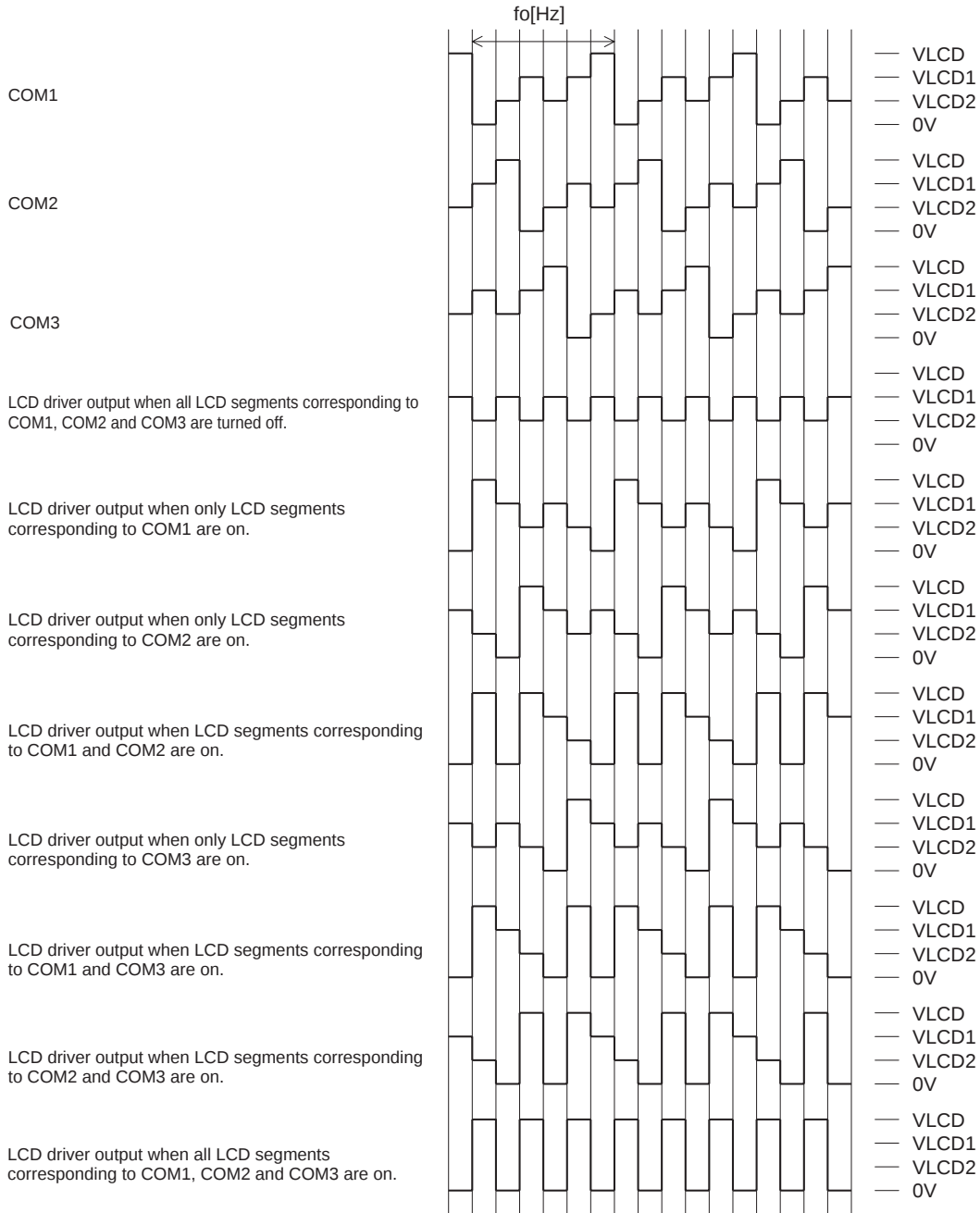
## 1/3 Duty, 1/2 Bias Drive Technique



## 1/3 Duty, 1/2 Bias Waveforms

|                                                              |                                                  |
|--------------------------------------------------------------|--------------------------------------------------|
| Note: When FC0 = 0, FC1 = 0, and FC2 = 0 in the control data | $f_0 = \frac{f_{osc}}{768} = \frac{f_{CK}}{768}$ |
| When FC0 = 0, FC1 = 0, and FC2 = 1 in the control data       | $f_0 = \frac{f_{osc}}{576} = \frac{f_{CK}}{576}$ |
| When FC0 = 0, FC1 = 1, and FC2 = 0 in the control data       | $f_0 = \frac{f_{osc}}{384} = \frac{f_{CK}}{384}$ |
| When FC0 = 0, FC1 = 1, and FC2 = 1 in the control data       | $f_0 = \frac{f_{osc}}{288} = \frac{f_{CK}}{288}$ |
| When FC0 = 1, FC1 = 0, and FC2 = 0 in the control data       | $f_0 = \frac{f_{osc}}{192} = \frac{f_{CK}}{192}$ |

## 1/3 Duty, 1/3 Bias Drive Technique



## 1/3 Duty, 1/3 Bias Waveforms

Note: When FC0 = 0, FC1 = 0, and FC2 = 0 in the control data  $f_0 = \frac{f_{osc}}{768} = \frac{f_{CK}}{768}$

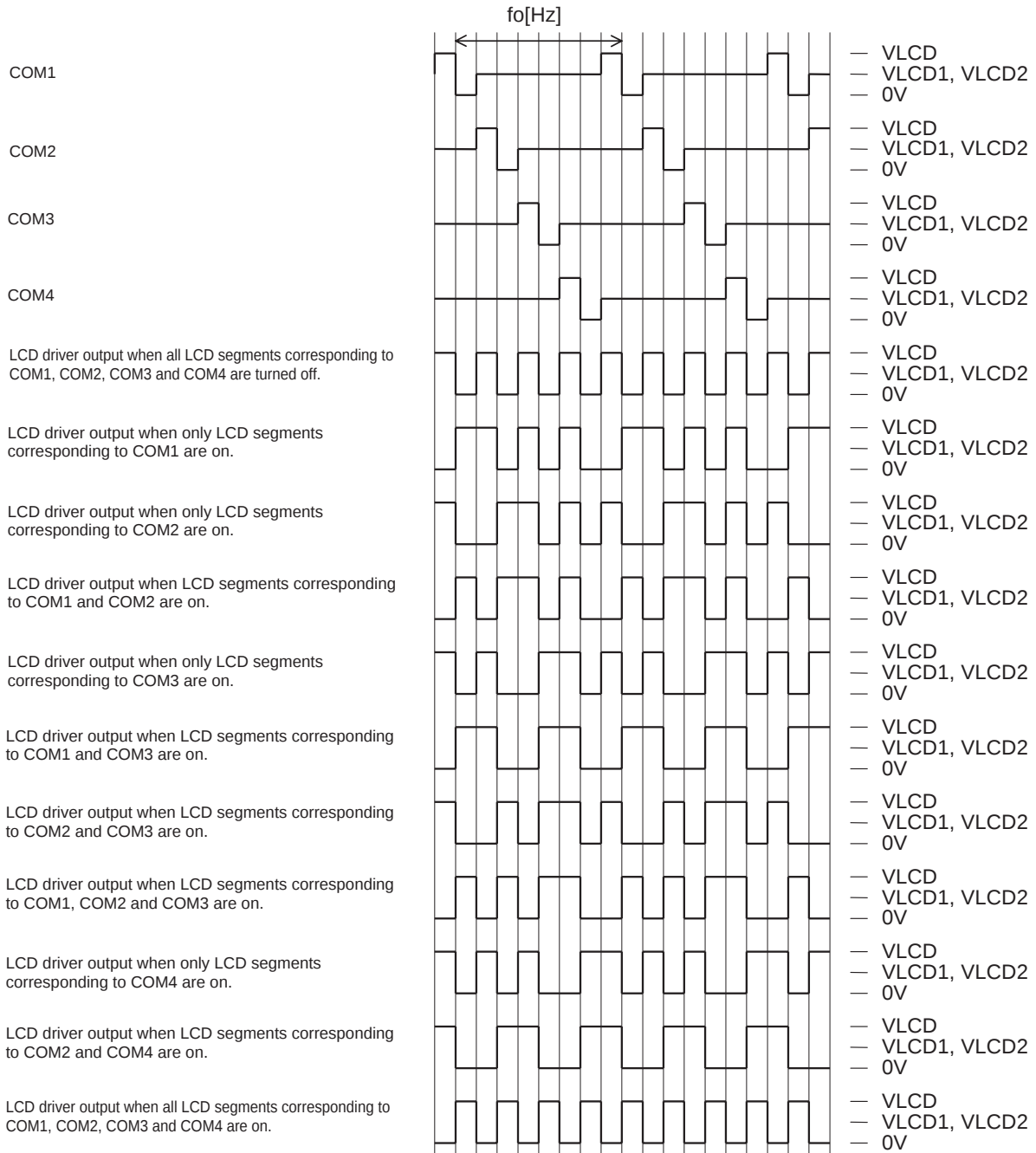
When FC0 = 0, FC1 = 0, and FC2 = 1 in the control data  $f_0 = \frac{f_{osc}}{576} = \frac{f_{CK}}{576}$

When FC0 = 0, FC1 = 1, and FC2 = 0 in the control data  $f_0 = \frac{f_{osc}}{384} = \frac{f_{CK}}{384}$

When FC0 = 0, FC1 = 1, and FC2 = 1 in the control data  $f_0 = \frac{f_{osc}}{288} = \frac{f_{CK}}{288}$

When FC0 = 1, FC1 = 0, and FC2 = 0 in the control data  $f_0 = \frac{f_{osc}}{192} = \frac{f_{CK}}{192}$

## 1/4 Duty, 1/2 Bias Drive Technique



## 1/4 Duty, 1/2 Bias Waveforms

Note: When FC0 = 0, FC1 = 0, and FC2 = 0 in the control data  $f_0 = \frac{f_{osc}}{768} = \frac{f_{CK}}{768}$

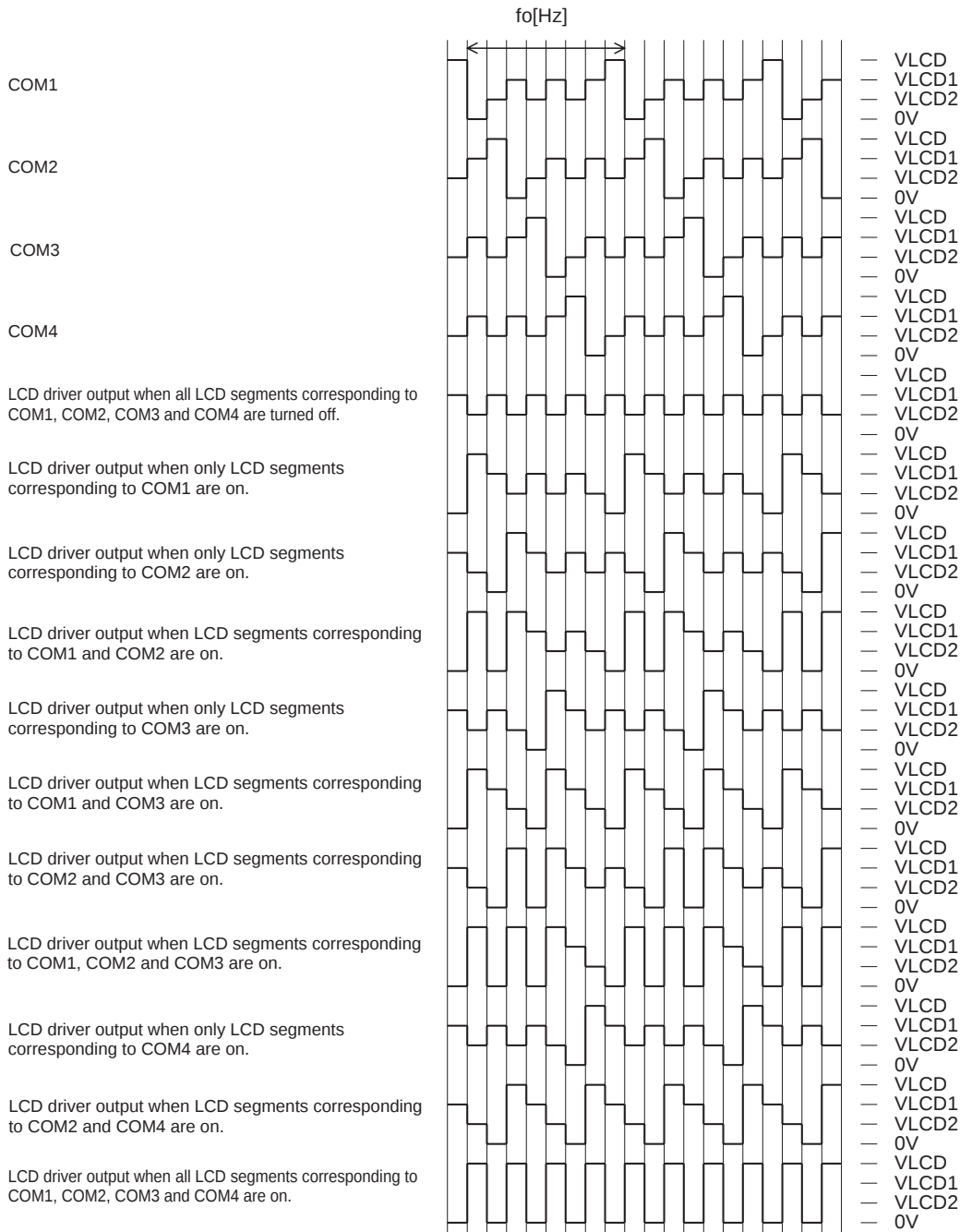
When FC0 = 0, FC1 = 0, and FC2 = 1 in the control data  $f_0 = \frac{f_{osc}}{576} = \frac{f_{CK}}{576}$

When FC0 = 0, FC1 = 1, and FC2 = 0 in the control data  $f_0 = \frac{f_{osc}}{384} = \frac{f_{CK}}{384}$

When FC0 = 0, FC1 = 1, and FC2 = 1 in the control data  $f_0 = \frac{f_{osc}}{288} = \frac{f_{CK}}{288}$

When FC0 = 1, FC1 = 0, and FC2 = 0 in the control data  $f_0 = \frac{f_{osc}}{192} = \frac{f_{CK}}{192}$

## 1/4 Duty, 1/3 Bias Drive Technique



## 1/4 Duty, 1/3 Bias Waveforms

Note: When FC0 = 0, FC1 = 0, and FC2 = 0 in the control data  $f_0 = \frac{f_{osc}}{768} = \frac{f_{CK}}{768}$

When FC0 = 0, FC1 = 0, and FC2 = 1 in the control data  $f_0 = \frac{f_{osc}}{576} = \frac{f_{CK}}{576}$

When FC0 = 0, FC1 = 1, and FC2 = 0 in the control data  $f_0 = \frac{f_{osc}}{384} = \frac{f_{CK}}{384}$

When FC0 = 0, FC1 = 1, and FC2 = 1 in the control data  $f_0 = \frac{f_{osc}}{288} = \frac{f_{CK}}{288}$

When FC0 = 1, FC1 = 0, and FC2 = 0 in the control data  $f_0 = \frac{f_{osc}}{192} = \frac{f_{CK}}{192}$

### Voltage Detection Type Reset Circuit (VDET)

This circuit generates an output signal and resets the system when logic block power is first applied and when the voltage drops, i.e., when the logic block power supply voltage is less than or equal to the power down detection voltage VDET, which is 2.2V, typical. To assure that this function operates reliably, a capacitor must be added to the logic block power supply line so that the logic block power supply voltage  $V_{DD}$  rise time when the logic block power is first applied and the logic block power supply voltage  $V_{DD}$  fall time when the voltage drops are both at least 1 ms. (See Figure 5 and Figure 6.)

### Power Supply Sequence

The following sequences must be observed when power is turned on and off. (See Figure 5 and Figure 6.)

- Power on :Logic block power supply( $V_{DD}$ ) on  $\rightarrow$  LCD driver block power supply( $V_{LCD}$ ) on
- Power off:LCD driver block power supply( $V_{LCD}$ ) off  $\rightarrow$  Logic block power supply( $V_{DD}$ ) off

However, if the logic and LCD driver block use a shared power supply, then the power supplies can be turned on and off at the same time.

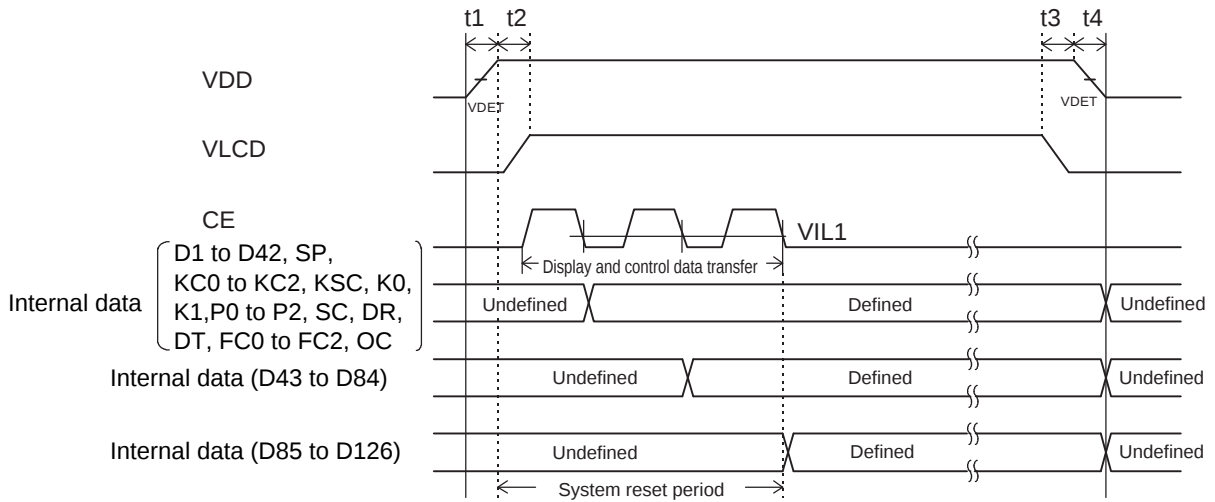
### System Reset

The LC75857E/W supports the reset methods described below. When a system reset is applied, display is turned off, key scanning is stopped, and all the key data is reset to low. When the reset is cleared, display is turned on and key scanning become possible.

#### 1. Reset methods

If at least 1 ms is assured as the logic block supply voltage  $V_{DD}$  rise time when logic block power is applied, a system reset will be applied by the VDET output signal when the logic block supply voltage is brought up. If at least 1 ms is assured as the logic block supply voltage  $V_{DD}$  fall time when logic block power drops, a system reset will be applied in the same manner by the VDET output signal when the supply voltage is lowered. Note that the reset is cleared at the point when all the serial data (1/3 duty: the display data D1 to D126 and the control data, 1/4 duty: the display data D1 to D164 and the control data) has been transferred, i.e., on the fall of the CE signal on the transfer of the last direction data, after all the direction data has been transferred. (See Figure 5 and Figure 6.)

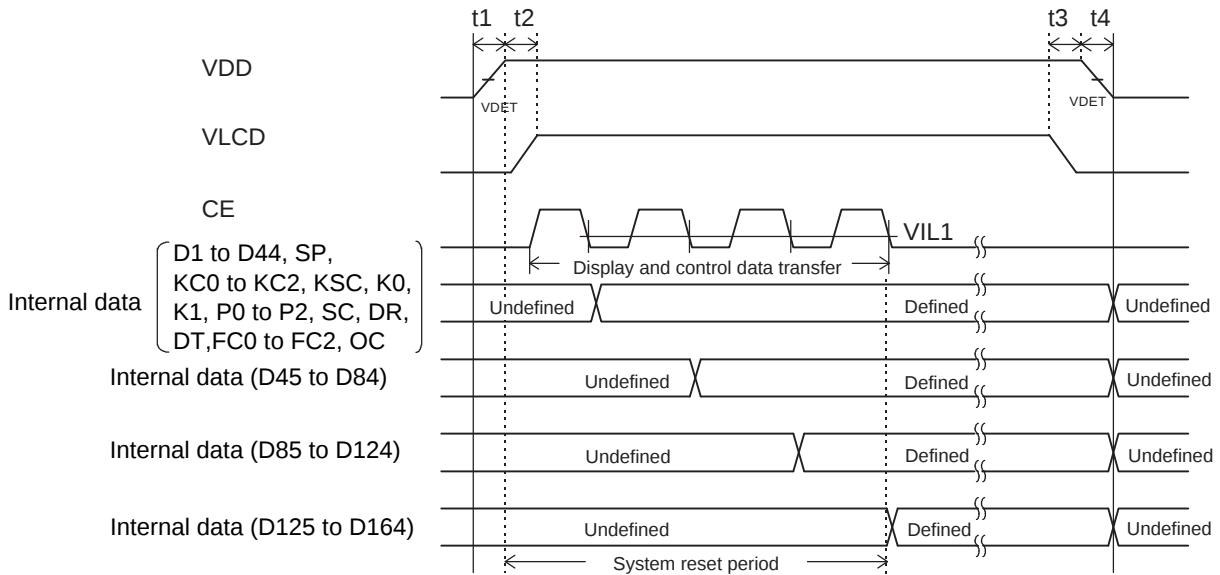
- 1/3 duty



Note:  $t_1 \geq 1$  [ms] (Logic block power supply voltage  $V_{DD}$  rise time)  
 $t_2 \geq 0$   
 $t_3 \geq 0$   
 $t_4 \geq 1$  [ms] (Logic block power supply voltage  $V_{DD}$  fall time)

Figure 5

- 1/4 duty

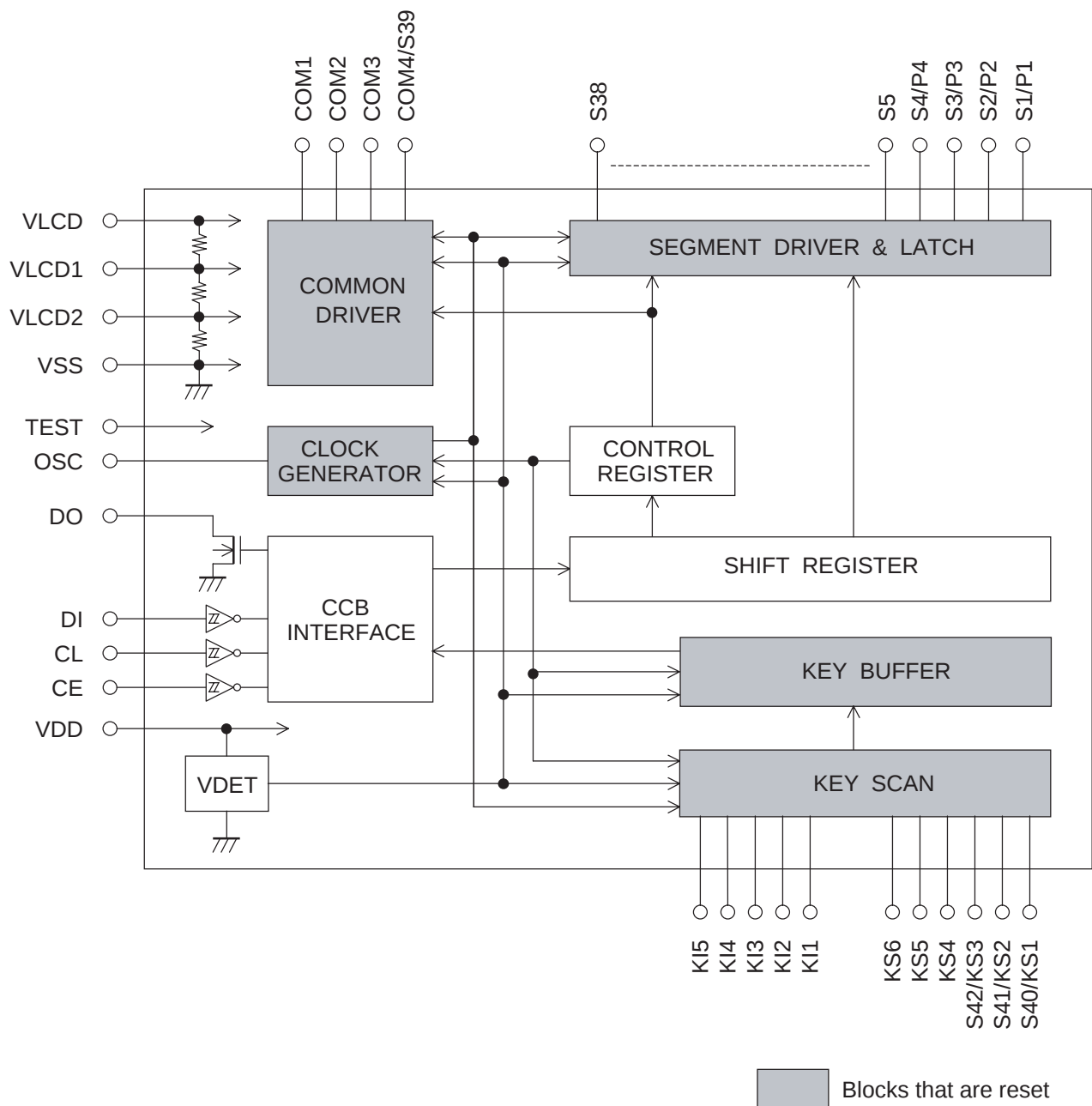


Note:  $t_1 \geq 1$  [ms] (Logic block power supply voltage  $V_{DD}$  rise time)  
 $t_2 \geq 0$   
 $t_3 \geq 0$   
 $t_4 \geq 1$  [ms] (Logic block power supply voltage  $V_{DD}$  fall time)

Figure 6

2. LC75857E/W internal block states during the reset period

- **CLOCK GENERATOR**  
A reset is applied and either the OSC pin oscillator is stopped or external clock input is stopped.
- **COMMON DRIVER, SEGMENT DRIVER & LATCH**  
Reset is applied and the display is turned off. However, display data can be input to the latch circuit in this state.
- **KEY SCAN**  
Reset is applied, the circuit is set to the initial state, and at the same time the key scan operation is disabled.
- **KEY BUFFER**  
Reset is applied and all the key data is set to low.
- **CCB INTERFACE, CONTROL REGISTER, SHIFT REGISTER**  
Since serial data transfer is possible, these circuits are not reset.



### 3. Pin states during the reset period

| pin                | State during reset |
|--------------------|--------------------|
| S1/P1 to S4/P4     | L *5               |
| S5 to S38          | L                  |
| COM1 to COM3       | L                  |
| COM4/S39           | L *6               |
| KS1/S40 to KS3/S42 | L *5               |
| KS4 to KS6         | L *7               |
| OSC                | Z *8               |
| DO                 | H *9               |

Notes:\*5. These output pins are forcibly set to the segment output function and held low.

\*6. When power is first applied, this output pin is forcibly set to the common output function and held low. However, when the DT control data bit is transferred, either the common output or the segment output function is selected.

\*7. This output pin is forcibly held fixed at the low level.

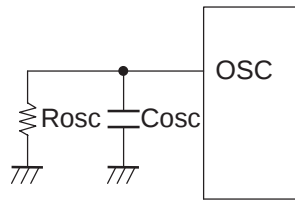
\*8. This I/O pin is forcibly set to the high-impedance state.

\*9. Since this output pin is an open-drain output, a pull-up resistor of between 1 and 10 k $\Omega$  is required. This pin remains high during the reset period even if a key data read operation is performed.

### Notes on the OSC Pin Peripheral Circuit

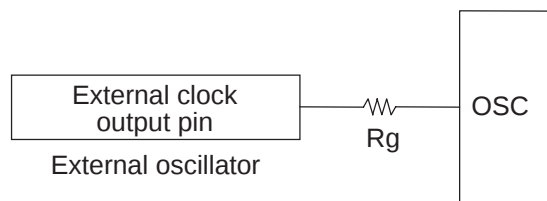
#### 1. RC oscillator mode (control data bit OC = 0)

When RC oscillator mode is selected, the external resistor  $R_{osc}$  and the external capacitor  $C_{osc}$  must be connected between the OSC pin and ground.



#### 2. External clock mode (control data bit OC = 1)

When external clock mode is selected, the current protection resistor  $R_g$  (4.7 to 47 k $\Omega$ ) must be connected between the OSC pin and the external clock output pin (external oscillator). The value of this resistor is determined by the allowable current for the external clock output pin. Verify that the external clock waveform is not deformed significantly.

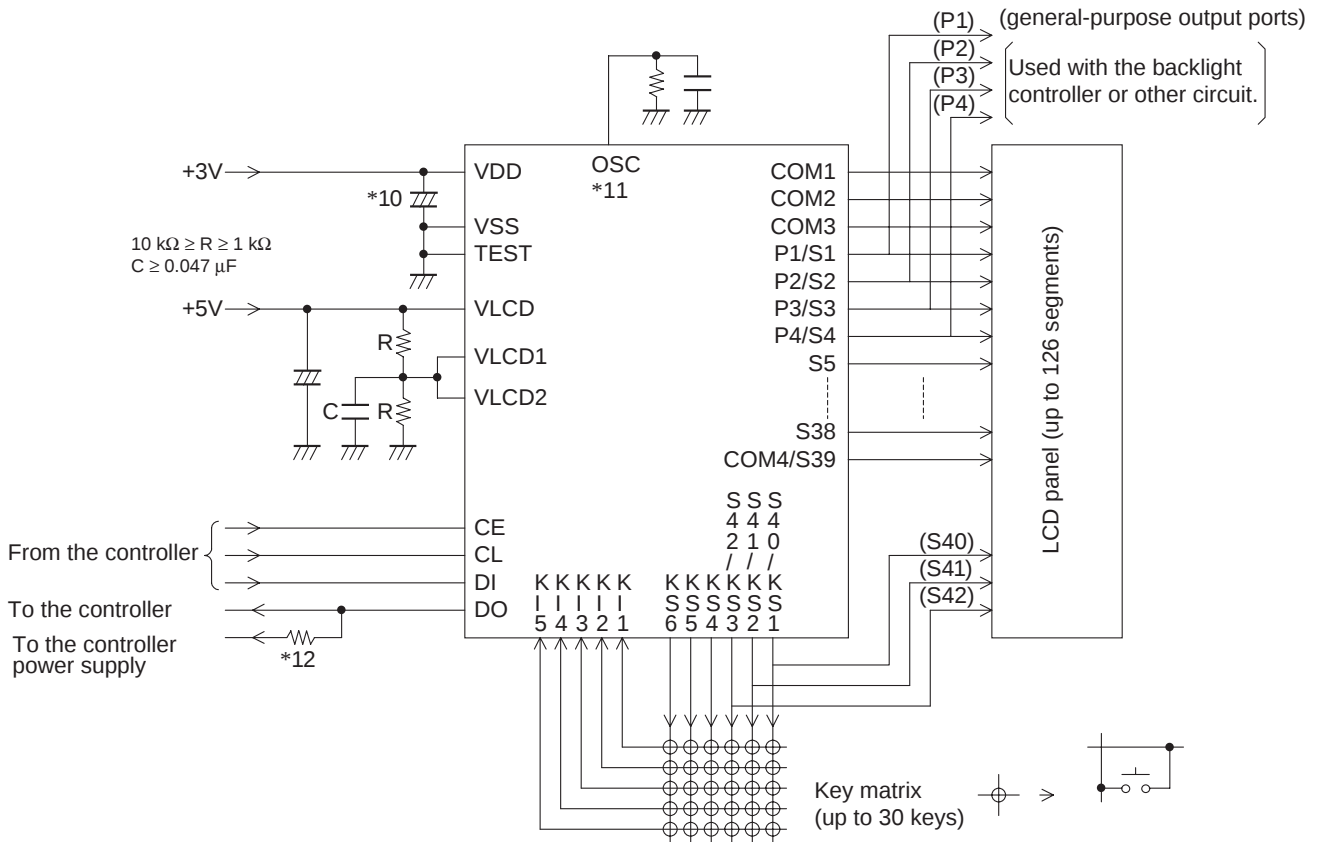


Note: The external clock output pin allowable current must be greater than  $V_{DD}/R_g$ .



## Sample Application Circuit 2

1/3 duty, 1/2 bias (for use with large panels)



Notes: \*10. Add a capacitor to the logic block power supply line so that the logic block power supply voltage  $V_{DD}$  rise time when power is applied and the logic block power supply voltage  $V_{DD}$  fall time when power drops are both at least 1 ms, as the LC75857E/W is reset by the VDET.

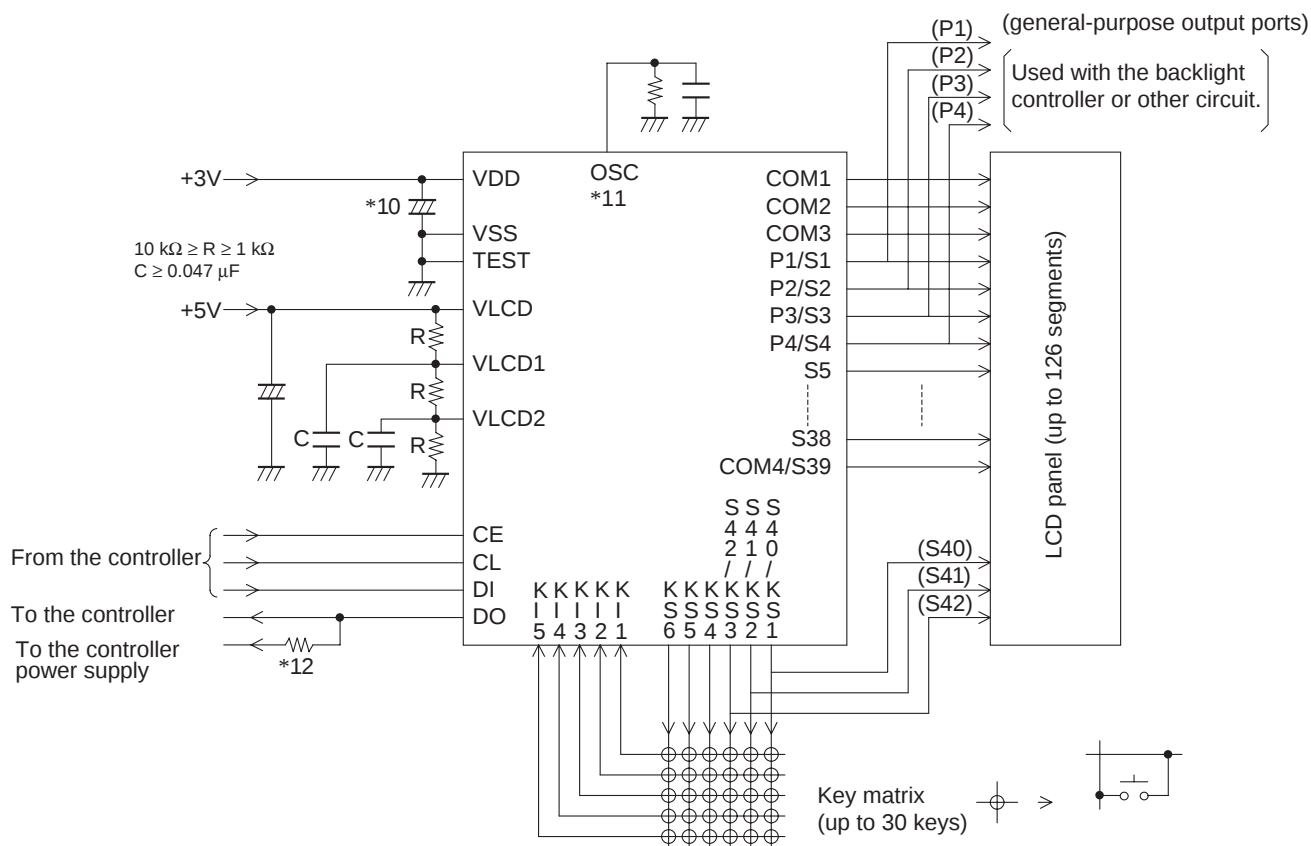
\*11. When RC oscillator mode is used, the external resistor  $R_{osc}$  and the external capacitor  $C_{osc}$  must be connected between the OSC pin and ground, and when external clock mode is selected the current protection resistor  $R_g$  (4.7 to 47 k $\Omega$ ) must be connected between the OSC pin and the external clock output pin (external oscillator). (See the section on the OSC pin peripheral circuit.)

\*12. The DO pin, being an open-drain output, requires a pull-up resistor. Select a resistance (between 1 to 10 k $\Omega$ ) appropriate for the capacitance of the external wiring so that signal waveforms are not degraded.



### Sample Application Circuit 4

1/3 duty, 1/3 bias (for use with large panels)



Notes: \*10. Add a capacitor to the logic block power supply line so that the logic block power supply voltage  $V_{DD}$  rise time when power is applied and the logic block power supply voltage  $V_{DD}$  fall time when power drops are both at least 1 ms. as the LC75857E/W is reset by the VDET.

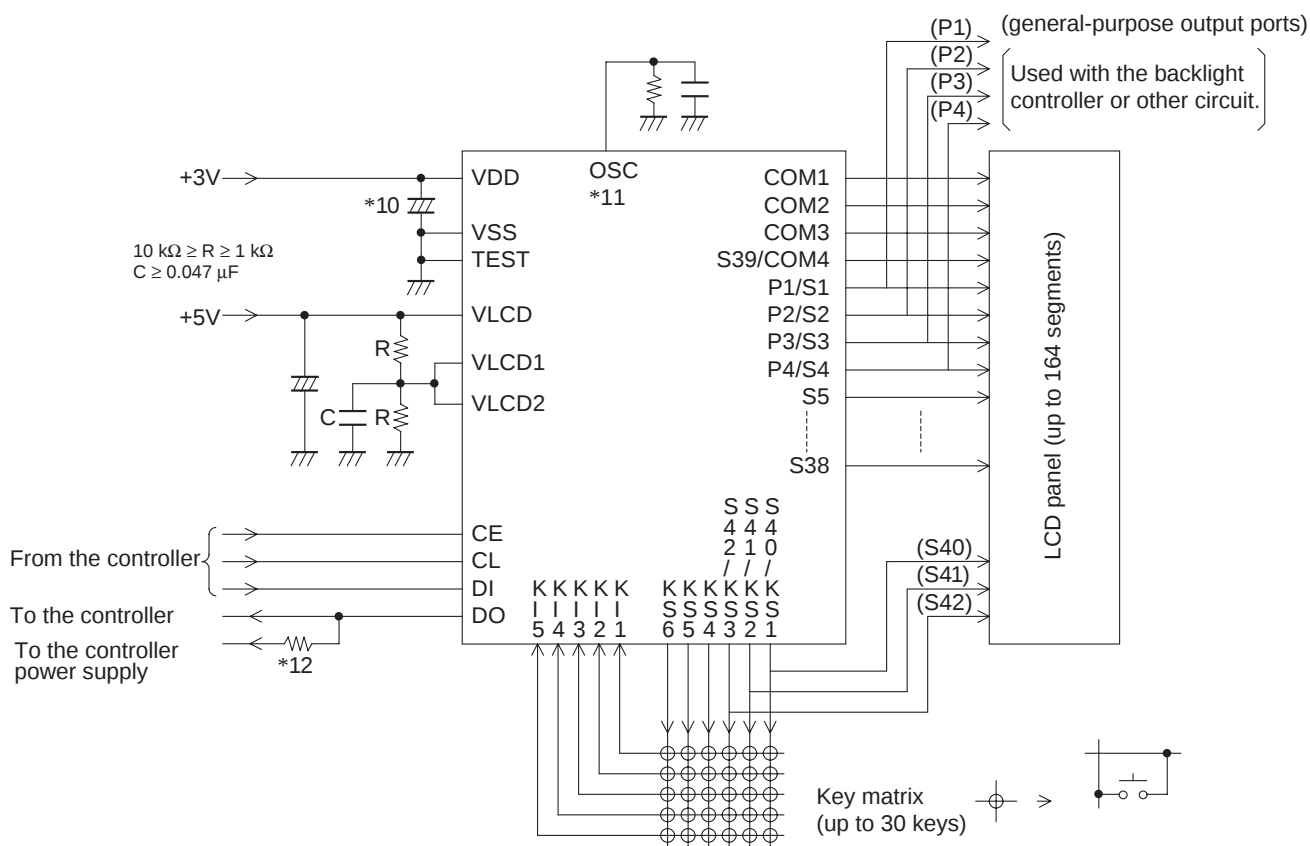
\*11. When RC oscillator mode is used, the external resistor R<sub>osc</sub> and the external capacitor C<sub>osc</sub> must be connected between the OSC pin and ground, and when external clock mode is selected the current protection resistor R<sub>g</sub> (4.7 to 47 kΩ) must be connected between the OSC pin and the external clock output pin (external oscillator). (See the section on the OSC pin peripheral circuit.)

\*12. The DO pin, being an open-drain output, requires a pull-up resistor. Select a resistance (between 1 to 10 k $\Omega$ ) appropriate for the capacitance of the external wiring so that signal waveforms are not degraded.



## Sample Application Circuit 6

1/4 duty, 1/2 bias (for use with large panels)



Notes: \*10. Add a capacitor to the logic block power supply line so that the logic block power supply voltage  $V_{DD}$  rise time when power is applied and the logic block power supply voltage  $V_{DD}$  fall time when power drops are both at least 1 ms, as the LC75857E/W is reset by the VDET.

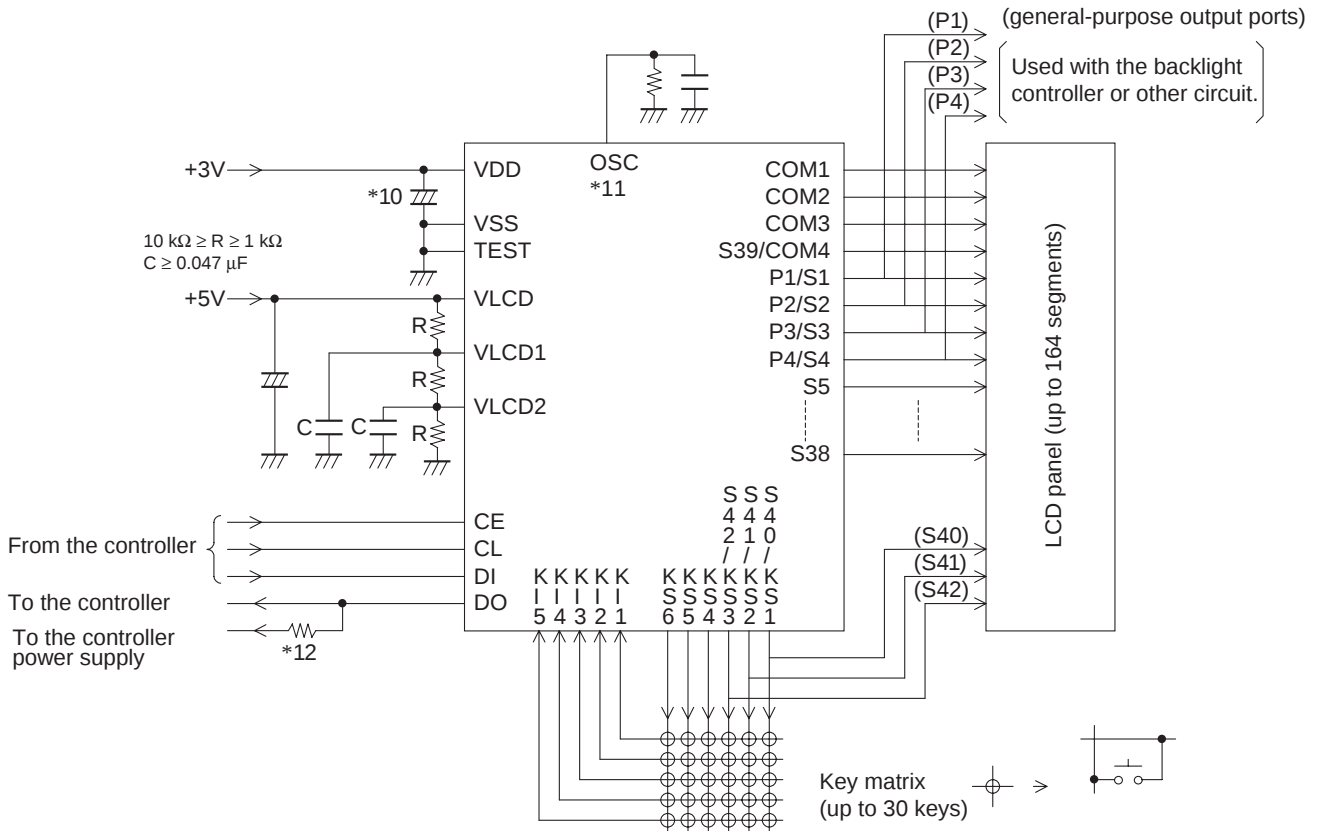
\*11. When RC oscillator mode is used, the external resistor R<sub>osc</sub> and the external capacitor C<sub>osc</sub> must be connected between the OSC pin and ground, and when external clock mode is selected the current protection resistor R<sub>g</sub> (4.7 to 47 kΩ) must be connected between the OSC pin and the external clock output pin (external oscillator). (See the section on the OSC pin peripheral circuit.)

\*12. The DO pin, being an open-drain output, requires a pull-up resistor. Select a resistance (between 1 to 10 k $\Omega$ ) appropriate for the capacitance of the external wiring so that signal waveforms are not degraded.



## Sample Application Circuit 8

1/4 duty, 1/3 bias (for use with large panels)



Notes: \*10. Add a capacitor to the logic block power supply line so that the logic block power supply voltage  $V_{DD}$  rise time when power is applied and the logic block power supply voltage  $V_{DD}$  fall time when power drops are both at least 1 ms, as the LC75857E/W is reset by the VDET.

\*11. When RC oscillator mode is used, the external resistor  $R_{osc}$  and the external capacitor  $C_{osc}$  must be connected between the OSC pin and ground, and when external clock mode is selected the current protection resistor  $R_g$  (4.7 to 47 k $\Omega$ ) must be connected between the OSC pin and the external clock output pin (external oscillator). (See the section on the OSC pin peripheral circuit.)

\*12. The DO pin, being an open-drain output, requires a pull-up resistor. Select a resistance (between 1 to 10 k $\Omega$ ) appropriate for the capacitance of the external wiring so that signal waveforms are not degraded.

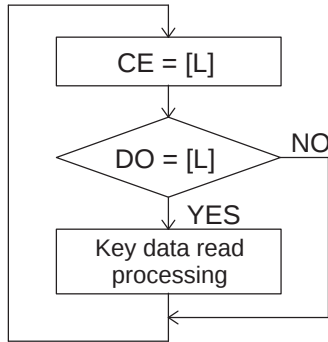
## Notes on transferring display data from the controller

When using the LC75857E/W in 1/3 duty, applications transfer the display data (D1 to D126) in three operations, and in 1/4 duty, they transfer the display data (D1 to D164) in four operations. In either case, applications should transfer all of the display data within 30 ms to maintain the quality of the displayed image.

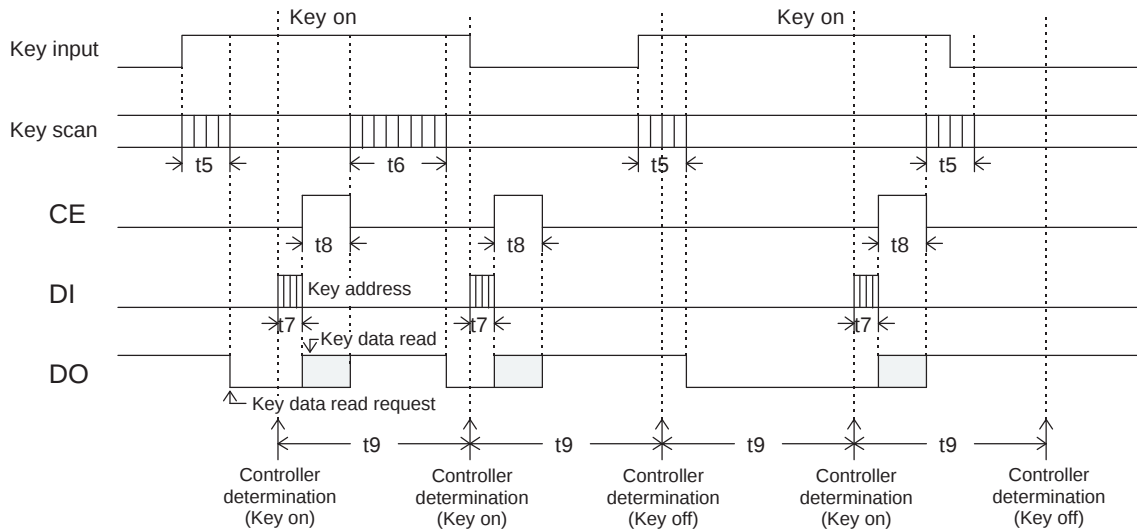
## Notes on the controller key data read techniques

### 1. Timer based key data acquisition

#### (1) Flowchart



#### (2) Timing chart



t5: Key scan execution time when the key data agreed for two key scans. (615T(s))

t6: Key scan execution time when the key data did not agree for two key scans and the key scan was executed again. (1230T(s))

t7: Key address (43H) transfer time

t8: Key data read time

$$T = \frac{1}{f_{osc}} = \frac{1}{f_{ck}}$$

#### (3) Explanation

In this technique, the controller uses a timer to determine key on/off states and read the key data. The controller must check the DO state when CE is low every t9 period without fail. If DO is low, the controller recognizes that a key has been pressed and executes the key data read operation.

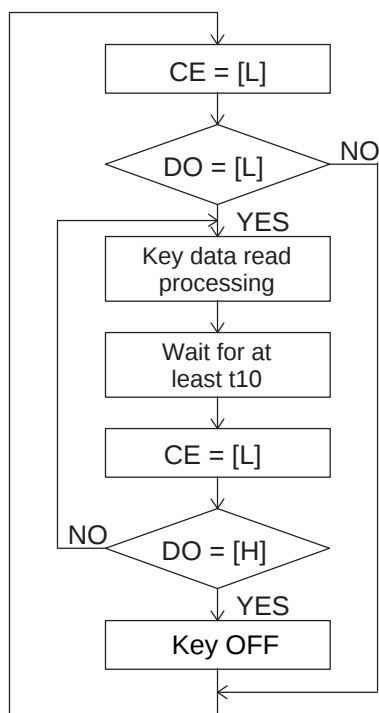
The period t9 in this technique must satisfy the following condition.

$$t9 > t6 + t7 + t8$$

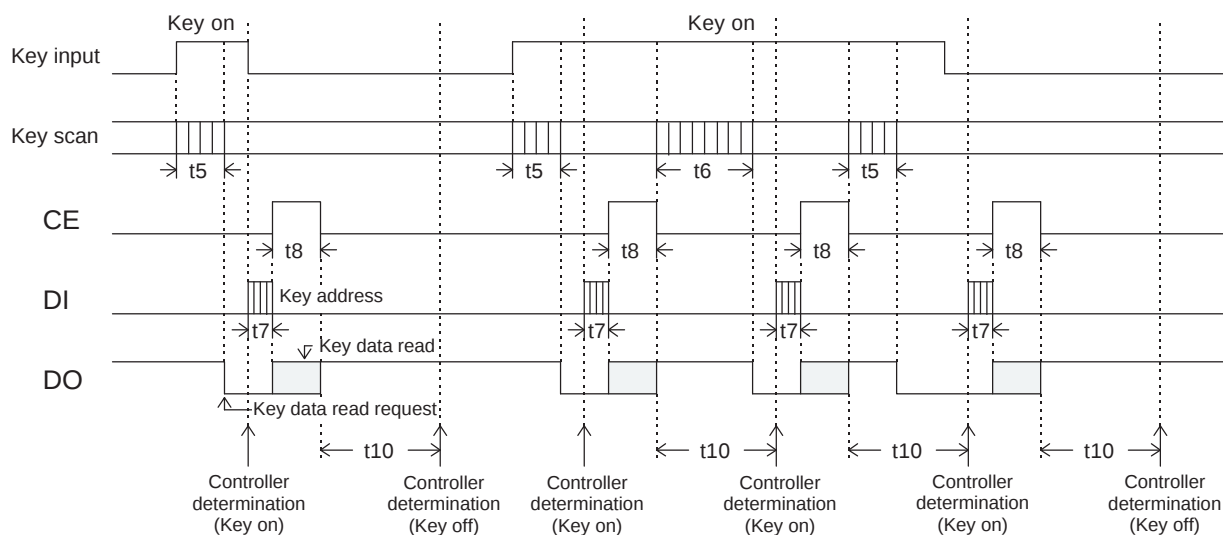
If a key data read operation is executed when DO is high, the read key data (KD1 to KD30) and sleep acknowledge data (SA) will be invalid.

## 2. Interrupt based key data acquisition

### (1) Flowchart



### (2) Timing chart



t5: Key scan execution time when the key data agreed for two key scans. (615T(s))

t6: Key scan execution time when the key data did not agree for two key scans and the key scan was executed again. (1230T(s))

t7: Key address (43H) transfer time

t8: Key data read time

$$T = \frac{1}{f_{osc}} = \frac{1}{f_{ck}}$$

**(3) Explanation**

In this technique, the controller uses interrupts to determine key on/off states and read the key data. The controller must check the DO state when CE is low. If DO is low, the controller recognizes that a key has been pressed and executes the key data read operation. After that the next key on/off determination is performed after the time t10 has elapsed by checking the DO state when CE is low and reading the key data. The period t10 in this technique must satisfy the following condition.

$$t10 > t6$$

If a key data read operation is executed when DO is high, the read key data (KD1 to KD30) and sleep acknowledge data (SA) will be invalid.

# LC75857E, LC75857W

## Package Dimensions

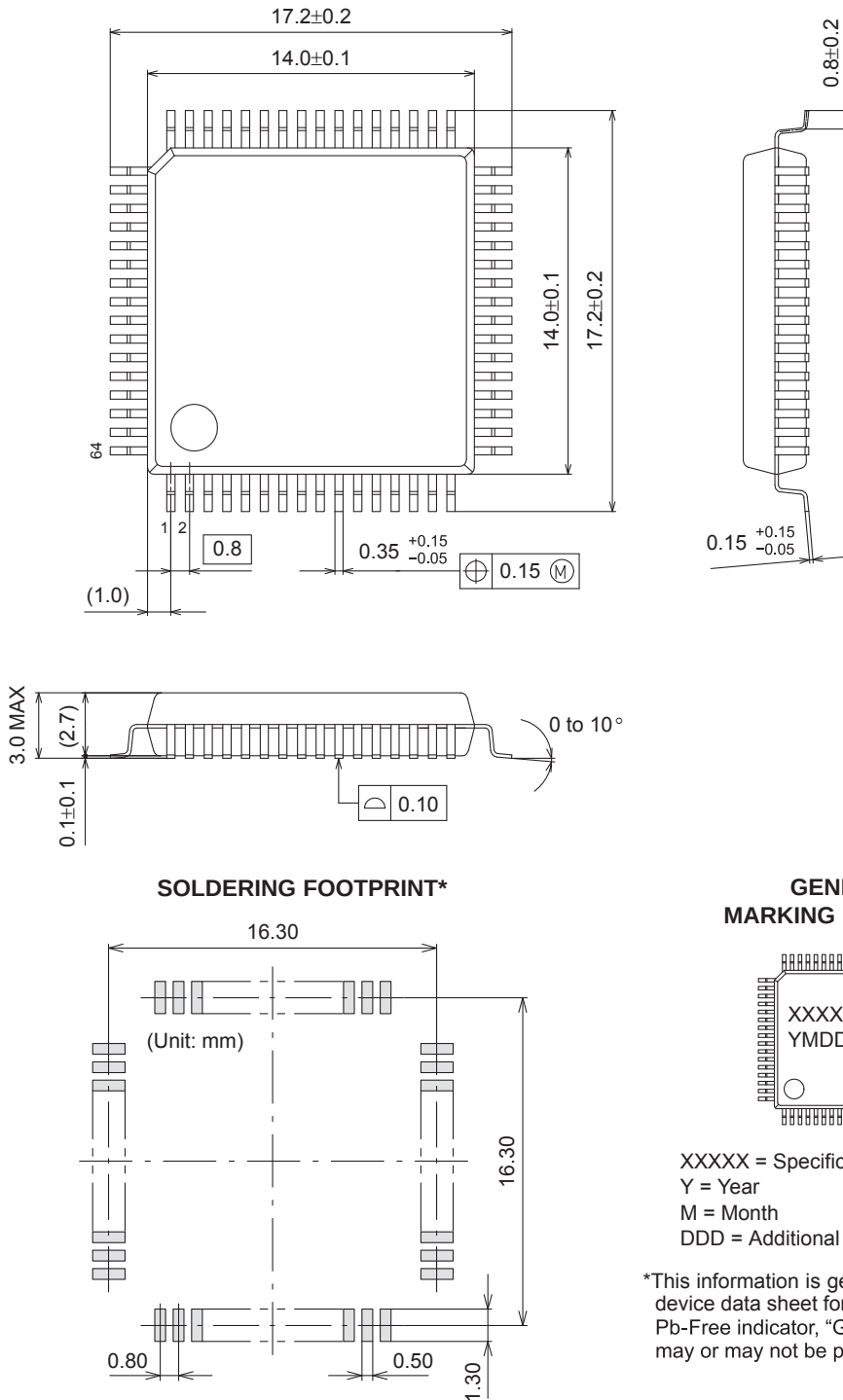
unit : mm

[LC75857E]

PQFP64 14x14 / QIP64E

CASE 122BP

ISSUE A



NOTE: The measurements are not to guarantee but for reference only.

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# LC75857E, LC75857W

## Package Dimensions

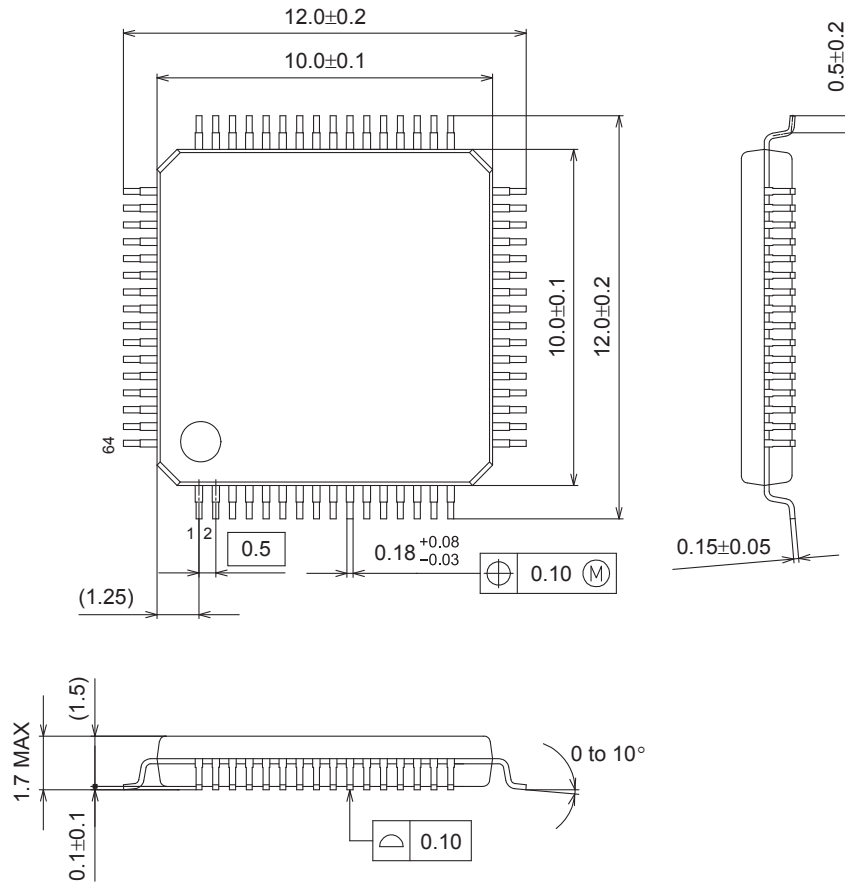
unit : mm

[LC75857W]

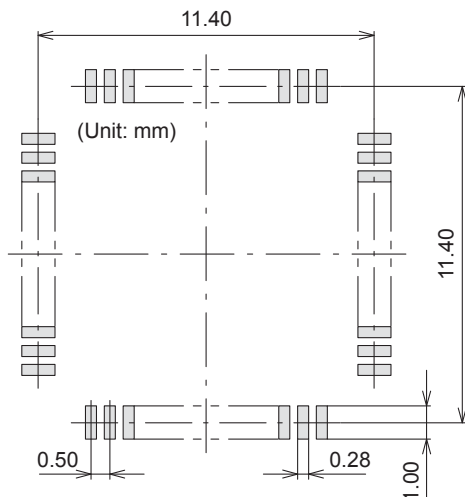
SPQFP64 10x10 / SQFP64

CASE 131AK

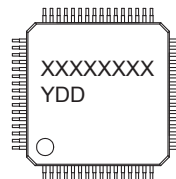
ISSUE A



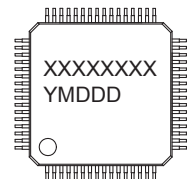
### SOLDERING FOOTPRINT\*



### GENERIC MARKING DIAGRAM\*



XXXXX = Specific Device Code  
Y = Year  
DD = Additional Traceability Data



XXXXX = Specific Device Code  
Y = Year  
M = Month  
DDD = Additional Traceability Data

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present.

NOTE: The measurements are not to guarantee but for reference only.

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERM/D.

## LC75857E, LC75857W

### ORDERING INFORMATION

| Device      | Package                             | Shipping (Qty / Packing) |
|-------------|-------------------------------------|--------------------------|
| LC75857E-E  | PQFP64 14x14 / QIP64E<br>(Pb-Free)  | 60 / Tray JEDEC          |
| LC75857ES-E | PQFP64 14x14 / QIP64E<br>(Pb-Free)  | 60 / Tray Foam           |
| LC75857W-E  | SPQFP64 10x10 / SQFP64<br>(Pb-Free) | 800 / Tray JEDEC         |
| LC75857WH-E | SPQFP64 10x10 / SQFP64<br>(Pb-Free) | 800 / Tray JEDEC         |
| LC75857WS-E | SPQFP64 10x10 / SQFP64<br>(Pb-Free) | 800 / Tray JEDEC         |

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